

Rockchip RK3368 Datasheet

**Revision 1.6
Aug. 2017**

Revision History

Date	Revision	Description
2017-8-15	1.6	Update pin information
2017-6-12	1.5	Update ball map info.
2016-9-20	1.4	Update
2016-6-2	1.3	Update
2015-11-24	1.2	Update
2015-5-9	1.1	Update
2015-3-23	1.0	Initial Release

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Chapter 1 Introduction

1.1 Overview

RK3368 is a low power, high performance processor for mobile phones, personal mobile internet device and other digital multimedia applications, and integrates octa-core Cortex-A53 with separately NEON coprocessor.

Many embedded powerful hardware engines provide optimized performance for high-end application. RK3368 supports almost full-format H.264 decoder by 4Kx2K@30fps, H.265 decoder by 4Kx2K@60fps, also support H.264/MVC/VP8 encoder by 1080p@30fps, high-quality JPEG encoder/decoder, and special image preprocessor and postprocessor.

Embedded 3D GPU makes RK3368 completely compatible with OpenGL ES3.1, OpenCL1.2 and DirectX 9.3. Special 2D hardware engine with MMU will maximize display performance and provide very smoothly operation.

RK3368 has high-performance external memory interface (DDR3/DDR3L/LPDDR2/LPDDR3) capable of sustaining demanding memory bandwidths, also provides a complete set of peripheral interface to support very flexible applications.

1.2 Features

The features listed below which may or may not be present in actual product, may be subject to the third party licensing requirements. Please contact Rockchip for actual product feature configurations and licensing requirements.

1.2.1 Micro Processor

- Octa-core ARM Cortex-A53 MPCore processor, a high-performance, low-power and cached application processor
- Two CPU clusters, with four CPU core for each cluster, One cluster is optimized for high-performance(big cluster) and the other is optimized for low power(little cluster)
- Full implementation of the ARM architecture v8-A instruction set, ARM Neon Advanced SIMD (single instruction, multiple data) support for accelerated media and signal processing computation
- ARMv8 Cryptography Extensions
- In-order pipeline with symmetric dual-issue of most instructions.
- Harvard Level 1 (L1) memory system with a Memory Management Unit (MMU).
- Level 2 (L2) memory system providing cluster memory coherency, including an L2 cache.
- Include VFP v3 hardware to support single and double-precision add, subtract, divide, multiply and accumulate, and square root operations
- SCU ensures memory coherency between the four CPUs for each cluster
- CCI400 ensures the memory coherency between the two clusters
- Integrated 32KB L1 instruction cache , 32KB L1 data cache with 4-way set associative
- 512KB unified L2 Cache for big cluster, 256KB unified L2 Cache for little cluster
- Trustzone technology support
- Full coresight debug solution
 - Debug and trace visibility of whole systems
 - ETM trace support
 - Invasive and non-invasive debug
- Ten separate power domains for CPU core system to support internal power switch and externally turn on/off based on different application scenario
 - PD_A53_L0: 1st Cortex-A53 + Neon + FPU + L1 I/D Cache of little cluster
 - PD_A53_L1: 2nd Cortex-A53 + Neon + FPU + L1 I/D Cache of little cluster
 - PD_A53_L2: 3rd Cortex-A53 + Neon + FPU + L1 I/D Cache of little cluster

- PD_A53_L3: 4th Cortex-A53 + Neon + FPU + L1 I/D Cache of little cluster
- PD_SCU_L: SCU + L2 Cache controller, and including PD_A53_L0, PD_A53_L1, PD_A53_L2, PD_A53_L3, debug logic of little cluster
- PD_A53_B0: 1st Cortex-A53 + Neon + FPU + L1 I/D Cache of big cluster
- PD_A53_B1: 2nd Cortex-A53 + Neon + FPU + L1 I/D Cache of big cluster
- PD_A53_B2: 3rd Cortex-A53 + Neon + FPU + L1 I/D Cache of big cluster
- PD_A53_B3: 4th Cortex-A53 + Neon + FPU + L1 I/D Cache of big cluster
- PD_SCU_B: SCU + L2 Cache controller, and including PD_A53_B0, PD_A53_B1, PD_A53_B2, PD_A53_B3, debug logic of big cluster
- One isolated voltage domain to support DVFS

1.2.2 Memory Organization

- Internal on-chip memory
 - BootRom
 - Internal SRAM for security and non-security access
- External off-chip memory^①
 - DDR3/DDR3L
 - LPDDR2
 - LPDDR3
 - Async Nand Flash(include LBA Nand)
 - Sync ONFI/toggle Nand Flash

1.2.3 Internal Memory

- Internal BootRom
 - Size : 20KB
 - Support system boot from the following device :
 - ◆ 8bits Async Nand Flash
 - ◆ 8bits toggle Nand Flash
 - ◆ SFC interface
 - ◆ eMMC interface
 - ◆ SDMMC interface
 - Support system code download by the following interface:
 - ◆ USB OTG interface
- Internal SRAM
 - Size : 68KB
 - Support security and non-security access
 - Security or non-security space is software programmable
 - Security space can be 0KB,4KB,8KB,12KB,16KB, ... up to 64KB by 4KB step

1.2.4 External Memory or Storage device

- Dynamic Memory Interface (DDR3-1600/DDR3L/LPDDR2/LPDDR3)
 - Compatible with JEDEC standard DDR3-1600/DDR3L/LPDDR2/LPDDR3 SDRAM
 - Support one channel: 16 or 32bits data widths and it's software programmable
 - Support up to 2 ranks (chip selects), totally 4GB(max) address space
 - 7 host ports with 64bits/128bits AXI bus interface for system access, AXI bus clock is asynchronous with DDR clock
 - Programmable timing parameters to support DDR3-1600/DDR3L/LPDDR2/LPDDR3 SDRAM from various vendor
 - Advanced command reordering and scheduling to maximize bus utilization
 - Low power modes, such as power-down and self-refresh for DDR3-1600/LPDDR2/LPDDR3 SDRAM; clock stop and deep power-down for LPDDR2/LPDDR3 SDRAM
 - Embedded dynamic drift detection in the PHY to get dynamic drift compensation with the controller
 - Programmable output and ODT impedance with dynamic PVT compensation
 - Support one low-power work mode: power down DDR PHY digital logic power, make

SDRAM still in self-refresh state to prevent data missing.

- Nand Flash Interface
 - Support async nand flash, each channel 8bits, up to 4 banks
 - Support sync DDR nand flash, each channel 8bits, up to 4 banks
 - Support LBA nand flash in async or sync mode
 - Up to 60bits hardware ECC
 - For async nand flash, support configurable interface timing , maximum data rate is 16bit/cycle
 - Embedded special DMA interface to do data transfer
 - Also support data transfer together with general PERI_DMAC in SoC system
- eMMC Interface
 - Compatible with standard iNAND interface
 - Support MMC4.5.1 protocol
 - Provide eMMC boot sequence to receive boot data from external eMMC device
 - Support FIFO over-run and under-run prevention by stopping card clock automatically
 - Support CRC generation and error detection
 - Embedded clock frequency division control to provide programmable baud rate
 - Support block size from 1 to 65535Bytes
 - 8bits data bus width
- SD/MMC Interface
 - Compatible with SD3.0, MMC ver4.5
 - Support FIFO over-run and under-run prevention by stopping card clock automatically
 - Support CRC generation and error detection
 - Embedded clock frequency division control to provide programmable baud rate
 - Support block size from 1 to 65535Bytes
 - Data bus width is 4bits

1.2.5 System Component

- CRU (clock & reset unit)
 - Support clock gating control for individual components inside RK3368
 - One oscillator with 24MHz clock input and 6 embedded PLLs
 - Up to 2.2GHz clock output for all PLLs
 - Support global soft-reset control for whole SOC, also individual soft-reset for every components
- PMU(power management unit)
 - Multiple configurable work modes to save power by different frequency or automatical clock gating control or power domain on/off control
 - Lots of wakeup sources in different mode
 - 3 separate voltage domains
 - 16 separate power domains, which can be power up/down by software based on different application scenes
- Timer
 - 12 on-chip 64bits Timers in SoC with interrupt-based operation for non-secure application
 - 2 on-chip 64bits Timers in SoC with interrupt-based operation for secure application
 - Provide two operation modes: free-running and user-defined count
 - Support timer work state checkable
 - Fixed 24MHz clock input
- PWM

- Four on-chip PWMs with interrupt-based operation
- Programmable pre-scaled operation to bus clock and then further scaled
- Embedded 32-bit timer/counter facility
- Support capture mode
- Support continuous mode or one-shot mode
- Provides reference mode and output various duty-cycle waveform
- WatchDog
 - 32 bits watchdog counter width
 - Counter clock is from apb bus clock
 - Counter counts down from a preset value to 0 to indicate the occurrence of a timeout
 - WDT can perform two types of operations when timeout occurs:
 - ◆ Generate a system reset
 - ◆ First generate an interrupt and if this is not cleared by the service routine by the time a second timeout occurs then generate a system reset
 - Programmable reset pulse length
 - Totally 16 defined-ranges of main timeout period
- Bus Architecture
 - 128bit/64-bit/32-bit multi-layer AXI/AHB/APB composite bus architecture
 - CCI400 embedded to support two Cortex-A53 cluster cache coherency
 - 5 embedded AXI interconnect
 - ◆ CPU interconnect with four 64-bits AXI masters, one 64-bits AXI slaves, one 32-bits AHB master and lots of 32-bits AHB/APB slaves
 - ◆ PERI interconnect with two 64-bits AXI masters, one 64-bits AXI slave, five 32-bits AHB masters and lots of 32-bits AHB/APB slaves
 - ◆ Display interconnect with three 128-bits AXI master, four 64-bits AXI masters and one 32-bits AHB slave
 - ◆ GPU interconnect with one 128-bits AXI master with point-to-point AXI-lite architecture and 32-bits APB slave
 - ◆ VCODEC interconnect also with two 64-bits AXI master and two 32-bits AHB slave, they are point-to-point AXI-lite architecture
 - For each interconnect with AXI/AHB/APB composite bus, clocks for AXI/AHB/APB domains are always synchronous, and different integer ratio is supported for them.
 - Flexible different QoS solution to improve the utility of bus bandwidth
- Interrupt Controller
 - Support 3 PPI interrupt source and 160 SPI interrupt sources input from different components inside RK3368
 - Support 16 software-triggered interrupts
 - Input interrupt level is fixed , only high-level sensitive
 - Two interrupt outputs (nFIQ and nIRQ) separately for each Cortex-A53, both are low-level sensitive
 - Support different interrupt priority for each interrupt source, and they are always software-programmable
- DMAC
 - Micro-code programming based DMA
 - The specific instruction set provides flexibility for programming DMA transfers
 - Linked list DMA function is supported to complete scatter-gather transfer
 - Support internal instruction cache
 - Embedded DMA manager thread
 - Support data transfer types with memory-to-memory, memory-to-peripheral, peripheral-to-memory
 - Signals the occurrence of various DMA events using the interrupt output signals
 - Mapping relationship between each channel and different interrupt outputs is

- software-programmable
- Two embedded DMA controller , BUS_DMAMAC is for bus system, PERI_DMAMAC is for peripheral system
- BUS_DMAMAC features:
 - ◆ 6 channels totally
 - ◆ 8 hardware request from peripherals
 - ◆ 2 interrupt output
 - ◆ Dual APB slave interface for register config, designated as secure and non-secure
 - ◆ Support trustzone technology and programmable secure state for each DMA channel
- PERI_DMAMAC features:
 - ◆ 7 channels totally
 - ◆ 17 hardware request from peripherals
 - ◆ 2 interrupt output
 - ◆ Not support trustzone technology
- Security system
 - Support trustzone technology for the following components inside RK3368
 - ◆ Cortex-A53, support security and non-security mode, switch by software
 - ◆ BUS_DMAMAC, support some dedicated channels work only in security mode
 - ◆ eFuse, only accessed by Cortex-A53 in security mode
 - ◆ Internal memory , part of space is addressed only in security mode, detailed size is software-programmable together with TZMA(trustzone memory adapter)
 - Embedded encryption and decryption engine
 - ◆ Support AES-128/192/256 with ECB, CBC, OFB, CTR, CBC-MAC, CMAC, XCBC-MAC, XTS and CCM modes
 - ◆ Supports the DES (ECB and CBC modes) and TDES (EDE and DED) algorithms
 - ◆ Supports SHA-1, SHA-256 and SHA-512 modes, as well as HMAC
 - ◆ Support all mathematical operations required to implement the PKA supported cryptosystems between 128 bits and 3136 bits in size (in steps of 32 bits)
 - ◆ Support random bits generator from the ring oscillator
 - ◆ Control the AIB interface to the OTP memory and providing an interface for the CPU to access to the non-confidential trusted data
 - ◆ Set the device's security lifecycle state according to the values of various flag words in the OTP memory
 - ◆ Provide an firmware interface for secure boot, secure debug
 - ◆ Provide a security processor sub-system based on an internal 32-bit CPU
 - Support security boot
 - Support security debug

1.2.6 Video CODEC

- Shared internal memory and bus interface for video decoder and encoder[®]
- Embedded memory management unit(MMU)
- Video Decoder
 - Real-time video decoder of MPEG-1, MPEG-2, MPEG-4, H.263, H.264, AVS, VC-1, VP8, MVC
 - Error detection and concealment support for all video formats
 - Output data format is YUV420 semi-planar, and YUV400(monochrome) is also supported for H.264
 - H.264 up to HP level 5.2 : 4Kx2K@30fps (4096x2304)[®]
 - MPEG-4 up to ASP level 5 : 1080p@60fps (1920x1088)
 - MPEG-2 up to MP : 2160p@30fps (3840x2160)
 - MPEG-1 up to MP : 1080p@60fps (1920x1088)
 - H.263 : 576p@60fps (720x576)
 - VC-1 up to AP level 3 : 1080p@30fps (1920x1088)
 - VP8 : 2160p@24fps (3840x2160)

- AVS : 1080p@60fps (1920x1088)
 - MVC : 2160p@30fps (3840x2160)
 - For AVS, 4:4:4 sampling not supported
 - For H.264, image cropping not supported
 - For MPEG-4, GMC(global motion compensation) not supported
 - For VC-1, upscaling and range mapping are supported in image post-processor
 - For MPEG-4 SP/H.263k, using a modified H.264 in-loop filter to implement deblocking filter in post-processor unit
- Video Encoder
 - Support video encoder for H.264 (BP@level4.0, MP@level4.0, HP@level4.0), MVC and VP8
 - Only support I and P slices, not B slices
 - Support error resilience based on constrained intra prediction and slices
 - Input data format:
 - ◆ YCbCr 4:2:0 planar
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbYCr 4:2:2
 - ◆ CbYCrY 4:2:2 interleaved
 - ◆ RGB444 and BGR444
 - ◆ RGB555 and BGR555
 - ◆ RGB565 and BGR565
 - ◆ RGB888 and BRG888
 - ◆ RGB101010 and BRG101010
 - Image size is from 96x96 to 1920x1088(Full HD)
 - Maximum frame rate is up to 30fps@1920x1080[®]
 - Bit rate supported is from 10Kbps to 20Mbps

1.2.7 HEVC Decoder

- Main HEVC/H.265 decoder by 4k@60FPS
- Support up to 4096x2304 resolution
- Support up to 100Mbps bit rate
- Embedded memory management unit(MMU)
- Stream error detector (28 IDs)
- Internal 128k cache for bandwidth reduction
- Multi-clock domains and auto clock-gating design for power saving

1.2.8 JPEG CODEC

- JPEG decoder
 - Input JPEG file : YCbCr 4:0:0, 4:2:0, 4:2:2, 4:4:0, 4:1:1 and 4:4:4 sampling formats
 - Output raw image : YCbCr 4:0:0, 4:2:0, 4:2:2, 4:4:0, 4:1:1 and 4:4:4 semi-planar
 - Decoder size is from 48x48 to 8176x8176(66.8Mpixels)
 - Support JPEG ROI(region of image) decode
 - Maximum data rate[®] is up to 76million pixels per second
 - Embedded memory management unit(MMU)
- JPEG encoder
 - Input raw image :
 - ◆ YCbCr 4:2:0 planar
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbYCr 4:2:2
 - ◆ CbYCrY 4:2:2 interleaved
 - ◆ RGB444 and BGR444
 - ◆ RGB555 and BGR555
 - ◆ RGB565 and BGR565

- ◆ RGB888 and BRG888
- ◆ RGB101010 and BRG101010
- Output JPEG file : JFIF file format 1.02 or Non-progressive JPEG
- Encoder image size up to 8192x8192(64million pixels) from 96x32
- Maximum data rate[®] up to 90million pixels per second
- Embedded memory management unit(MMU)

1.2.9 Image Enhancement

- Image pre-processor
 - Only used together with HD video encoder inside RK3368, not support stand-alone mode
 - Provides RGB to YCbCr 4:2:0 color space conversion, compatible with BT601, BT709 or user defined coefficients
 - Provides YCbCr4:2:2 to YCbCr4:2:0 color space conversion
 - Support cropping operation from 8192x8192 to any supported encoding size
 - Support rotation with 90 or 270 degrees
- Video stabilization
 - Work in combined mode with HD video encoder inside RK3368 and stand-alone mode
 - Adaptive motion compensation filter
 - Support scene detection from video sequence, encodes key frame when scene change noticed
- Image Post-Processor (embedded inside video decoder)
 - Combined with HD video decoder and JPEG decoder, post-processor can read input data directly from decoder output to reduce bus bandwidth
 - Also work as a stand-alone mode, its input data is from image data stored in external memory
 - Input data format:
 - ◆ Any format generated by video decoder in combined mode
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbCr 4:2:0 planar
 - ◆ YCbYCr 4:2:2
 - ◆ YCrYCb 4:2:2
 - ◆ CbYCrY 4:2:2
 - ◆ CrYCbY 4:2:2
 - Output data format:
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbYCr 4:2:2
 - ◆ YCrYCb 4:2:2
 - ◆ CbYCrY 4:2:2
 - ◆ CrYCbY 4:2:2
 - ◆ Fully configurable ARGB channel lengths and locations inside 32bits, such as ARGB8888, RGB565, ARGB4444 etc.
 - Input image size:
 - ◆ Combined mode: from 48x48 to 8176x8176 (66.8Mpixels)
 - ◆ Stand-alone mode: width from 48 to 8176,height from 48 to 8176, and maximum size limited to 16.7Mpixels
 - ◆ Step size is 16 pixels
 - Output image size: from 16x16 to 1920x1088 (horizontal step size 8,vertical step size 2)
 - Support image up-scaling:
 - ◆ Bicubic polynomial interpolation with a four-tap horizontal kernel and a two-tap vertical kernel
 - ◆ Arbitrary non-integer scaling ratio separately for both dimensions
 - ◆ Maximum output width is 3x input width
 - ◆ Maximum output height is 3x input height
 - Support image down-scaling:

- ◆ Arbitrary non-integer scaling ratio separately for both dimensions
- ◆ Unlimited down-scaling ratio
- Support YUV to RGB color conversion, compatible with BT.601-5, BT.709 and user definable conversion coefficient
- Support dithering (2x2 ordered spatial dithering) for 4/5/6bit RGB channel precision
- Support programmable alpha channel and alpha blending operation with the following overlay input formats:
 - ◆ 8bit alpha + YUV444, big endian channel order with AYUV8888
 - ◆ 8bit alpha + 24bit RGB, big endian channel order with ARGB8888
- Support deinterlacing with conditional spatial deinterlace filtering, only compatible with YUV420 input format
- Support RGB image contrast/brightness/color saturation adjustment
- Support image cropping & digital zoom only for JPEG or stand-alone mode
- Support picture in picture
- Support image rotation (horizontal flip, vertical flip, rotation 90,180 or 270 degrees)
- Image Enhancement-Processor (IEP)
 - Image format
 - ◆ Input data: XRGB/RGB565/YUV420/YUV422
 - ◆ Output data: ARGB/RGB565/YUV420/YUV422
 - ◆ The format ARGB/XRGB/RGB565/YUV support swap
 - ◆ Support YUV semi-planar/planar
 - ◆ Support BT601_l/BT601_f/BT709_l/BT709_f color space conversion
 - ◆ Support RGB dither up/down conversion
 - ◆ Support YUV up/down sampling conversion
 - ◆ Max source image resolution: 8192x8192
 - ◆ Max scaled image resolution: 4096x4096
 - Enhancement
 - ◆ Gamma adjustment with programmable mapping table
 - ◆ Hue/Saturation/Brightness/Contrast enhancement
 - ◆ Color enhancement with programmable coefficient
 - ◆ Detail enhancement with filter matrix up to 9x9
 - ◆ Edge enhancement with filter matrix up to 9x9
 - ◆ Programmable difference table for detail enhancement
 - ◆ Programmable distance table for detail and edge enhancement
 - Noise reduction
 - ◆ Compression noise reduction with filter matrix up to 9x9
 - ◆ Programmable difference table for compression noise reduction
 - ◆ Programmable distance table for compression noise reduction
 - ◆ Spatial sampling noise reduction
 - ◆ Temporal sampling noise reduction
 - ◆ Optional coefficient for sampling noise reduction
 - Scaling
 - ◆ Horizontal down-scaling with vertical down-scaling
 - ◆ Horizontal down-scaling with vertical up-scaling
 - ◆ Horizontal up-scaling with vertical down-scaling
 - ◆ Horizontal up-scaling with vertical up-scaling
 - ◆ Arbitrary non-integer scaling ratio, from 1/16 to 16
 - Deinterlace
 - ◆ Input 4 fields, output 2 frames mode
 - ◆ Input 4 fields, output 1 frames mode
 - ◆ Input 2 fields, output 1 frames mode
 - ◆ Programmable motion detection coefficient
 - ◆ Programmable high frequency factor
 - ◆ Programmable edge interpolation parameter
 - ◆ Source width up to 1920

- Max resolution for dynamic image
 - ◆ Deinterlace: 1920x1080
 - ◆ Sampling noise reduction: 1920x1080
 - ◆ Compression noise reduction: 4096x2304
 - ◆ Enhancement: 4096x2304
- Interface
 - ◆ Programmable direct path to VOP
- Embedded memory management unit(MMU)

1.2.10 Graphics Engine

- 3D Graphics Engine :
 - Base handheld architecture fully Microsoft® DirectX™ 9.3, OpenGL® 3.1, and OpenGL ES 3 compliant
 - Support for pull-model attribute evaluation
 - Tile-based deferred rendering architecture with concurrent processing of multiple tiles
 - Multi-threaded Unified Shading Cluster (USC) engine incorporating pixel shader, vertex shader, and GP-GPU (compute shader) functionality
 - USC incorporates an ALU architecture with high SIMD efficiency
 - Fully virtualised memory addressing (up to 1 TB address space), supporting unified memory architecture
 - Fine-grained task switching, workload balancing and power management
 - Dedicated processor for Rogue core firmware execution
- 2D Graphics Engine :
 - BitBlit with Stretch Blit, Simple Blit and Filter Blit
 - Color fill with gradient fill, and pattern fill
 - Line drawing with anti-aliasing and specified width
 - High-performance stretch and shrink
 - Monochrome expansion for text rendering
 - ROP2, ROP3, ROP4
 - Alpha blending modes including global alpha, per pixel alpha, porter-duff and fading
 - 8K x 8K input and 2K x 2K output raster 2D coordinate system
 - Arbitrary degrees rotation with anti-aliasing on every 2D primitive
 - Blending, scaling and rotation are supported in one pass for Bitblit
 - Source format:
 - ◆ ABGR8888, XBGR888, ARGB8888, XRGB888
 - ◆ RGB888, RGB565
 - ◆ RGBA5551, RGBA4444
 - ◆ YUV420 planar, YUV420 semi-planar
 - ◆ YUV422 planar, YUV422 semi-planar
 - ◆ BPP8, BPP4, BPP2, BPP1
 - Destination formats:
 - ◆ ABGR8888, XBGR888, ARGB8888, XRGB888
 - ◆ RGB888, RGB565
 - ◆ RGBA5551, RGBA4444
 - ◆ YUV420 planar, YUV420 semi-planar only in filter and pre-scale mode
 - ◆ YUV422 planar, YUV422 semi-planar only in filter and pre-scale mode

1.2.11 Video IN/OUT

- Camera Interface(interface only)
 - Support up to 5M pixels
 - 8bits BT656(PAL/NTSC) interface
 - 16bits BT601 DDR interface
 - 8bits/10bits/12bits raw data interface

- YUV422 data input format with adjustable YUV sequence
 - YUV422,YUV420 output format with separately Y and UV space
 - Support picture in picture (PIP)
 - Support simple image effects such as Arbitrary(sepia), Negative, Art freeze, Embossing etc.
 - Support static histogram statistics and white balance statistics
 - Support image crop with arbitrary windows
 - Support scale up/down from 1/8 to 8 with arbitrary non-integer ratio
- Camera Interface and Image Processor(Interface and Image Processing)
 - Maximum input resolution of 8M(3264x2448) pixels
 - Main scaler with pixel-accurate up- and down-scaling to any resolution between 3264x2448 and 32x16 pixel in processing mode
 - Self scaler with pixel-accurate up- and down-scaling to any resolution between 1920x1080 and 32x16 pixel in processing mode
 - support of semiplanar NV21 color storage format
 - support of independent image cropping on main and self path
 - ITU-R BT 601/656 compliant video interface supporting YCbCr or RGB Bayer data
 - 12 bit camera interface
 - 12 bit resolution per color component internally
 - YCbCr 4:2:2 processing
 - quantization and Huffman tables
 - Windowing and frame synchronization
 - Macro block line, frame end, capture error, data loss interrupts and sync. (h_start, v_start) interrupts
 - Luminance/chrominance and chrominance blue/red swapping for YUV input signals
 - Continuous resize support
 - Color processing (contrast, saturation, brightness, hue, offset, range)
 - Display-ready RGB output in self-picture path (RGB888, RGB666 and RGB565)
 - Rotation unit in self-picture path (90°, 180°, 270° and h/v flipping) for RGB output
 - Read port provided to read back a picture from system memory
 - Simultaneous picture read back, resizing and storing through self path while main path captures the camera picture
 - Black level compensation
 - Four channel Lens shade correction (Vignetting)
 - Auto focus measurement
 - White balancing and black level measurement
 - Auto exposure support by brightness measurement in 5x5 sub windows
 - Defect pixel cluster correction unit (DPCC) supports on the fly and table based pixel correction
 - De-noising pre filter (DPF)
 - Enhanced color interpolation (RGB Bayer demosaicing)
 - Chromatic aberration correction
 - Combined edge sensitive Sharpening / Blurring filter (Noise filter)
 - Color correction matrix (cross talk matrix)
 - Global Tone Mapping with wide dynamic range unit (WDR)
 - Image Stabilization support and Video Stabilization Measurement
 - Flexible Histogram calculation
 - Digital image effects (Emboss, Sketch, Sepia, B/W (Grayscale), Color Selection, Negative image, sharpening)
 - Solarize effect through gamma correction
- Display Interface
 - Embedded one channel display interfacesT.
 - Parallel Display interface
 - ◆ Parallel RGB LCD Interface:
 - 24-bit(RGB888),18-bit(RGB666), 15-bit(RGB565)

- ◆ dither down:
 - allegro, FRC
 - gamma after dither
- ◆ Max output resolution: 4096x2304
- ◆ Scanning timing 8192x4096
- IFDBC
 - ◆ decompress FB generated by GPU FBC
 - ◆ support 2048x1536 UI
 - ◆ support ARGB888,RGB888,RGB565
 - ◆ output for one layer among WIN0/1/2/3
 - ◆ only support one IFDBC block which can used for WIN0/1/2/3 by configuration
- Display process
 - ◆ Background layer:
 - programmable 24-bit color
 - ◆ Win0 (Video0) layer:
 - RGB888, ARGB888, RGB565, YCbCr422, YCbCr420, YCbCr444
 - Support virtual display
 - 1/8 to 8 scaling-down and scaling-up engine:
 - ✧ Scale up using bicubic or bilinear;
 - ✧ Scale down using bilinear or average;
 - ✧ 4 Bicubic tables : precise,spline,catrom,mitchell;
 - ✧ coord 8bit, coe 8bit signed
 - x-mirror,y-mirror
 - ◆ Win1 (Video1) layer:
 - RGB888, ARGB888, RGB565, YCbCr422, YCbCr420, YCbCr444
 - Support virtual display
 - 1/8 to 8 scaling-down and scaling-up engine
 - ✧ Scale up using bicubic or bilinear;
 - ✧ Scale down using bilinear otraverage;
 - ✧ 4 Bicubic tables : precise,spline,catrom,mitchell;
 - ✧ coord 8bit, coe 8bit signed
 - x-mirror,y-mirror
 - ◆ Win2 (UI 0) layer:
 - RGB888, ARGB888, RGB565, 1/2/4/8bpp
 - Support virtual display
 - 4 display regions
 - x-mirror,y-mirror
 - ◆ Win3 (UI 1) layer:
 - RGB888, ARGB888, RGB565, 1/2/4/8bpp
 - Support virtual display
 - 4 display regions
 - x-mirror,y-mirror
 - ◆ Hardware cursor:
 - RGB888, ARGB888, RGB565, 1/2/4/8bpp
 - Support two size: 32x32,64x64,or 128x128
 - ◆ Overlay:
 - Win0/Win1/Win2/Win3 256 level alpha blending (support pre-multiplied alpha)
 - Win0/Win1/Win2/Win3 overlay position exchangeable
 - Win0/Win1/Win2/Win3 Transparency color key
 - Win0/Win1/Win2/Win3 global/per-pixel alpha
 - HWC 256 level alpha blending
 - HWC global/per-pixel alpha
- Others
 - ◆ 3 x 256 x 8 bits display LUTs
 - ◆ YcbCr2RGB(rec601-mpeg/rec601-jpeg/rec709/BT2020)and RGB2YcbCr
 - ◆ Support BCSH function

- ◆ Support CABC function
- ◆ QoS request signals
- ◆ Gather transfer (Max 8)
- ◆ Y/UV scheduler
- ◆ Addr alignment
- ◆ Support IEP direct path(win0/1/2/3)
- ◆ Embedded memory management unit(MMU)
- ◆ Support MIPI flow control

1.2.12 HDMI

- Single Physical Layer PHY with support for HDMI 1.4 and 2.0 operation
- For HDMI operation, support for the following:
 - Up to 1080p at 120 Hz and 4k x 2k at 60 Hz HDTV display resolutions and up to QXGA graphic display resolutions
 - 3-D video formats
 - Up to 10-bit Deep Color modes
 - Up to 18 Gbps aggregate bandwidth
 - 13.5–600 MHz input reference clock
 - HPD input analog comparator
- Link controller flexible interface with 30-, 60- or 120-bit SDR data access
- Support HDCP 1.4/HDCP2.2

1.2.13 MIPI_DSI/LVDS/TTL combo PHY

- MIPI_TX
 - Support 4 data lane, providing up to 4Gbps data rate
 - Support 1080p @ 60fps output
- LVDS
 - Comply with the TIA/EIA-644-A LVDS standard
 - Combine LVTTTL IO, support LVDS/LVTTTL data output
 - Support reference clock frequency range from 10Mhz to 148.5Mhz
 - Support LVDS RGB 24/18bits color data transfer
 - Support VESA/JEIDA LVDS data format transfer
- TTL
 - Combine LVTTTL IO, support LVDS/LVTTTL data output

1.2.14 MIPI_CSI PHY

- Embedded one MIPI_CSI PHY
- Support 4 data lane, providing up to 4Gbps data rate

1.2.15 eDP PHY

- Support 4Kx2K @ 30fps
- Compliant with eDP TM Specification, version 1.1
- Up to 4 physical lanes of 2.7/1.62 Gbps/lane(HBR2/HBR/RBR)
- RGB, YCbCr 4:4:4, YCbCr 4:2:2 and 8/10/12 bit per component video format
- Encoded bit stream (Dolby Digital) – IEC61937 compliant
- Support VESA DMT and CVT timing standards
- Fully support EIA/CEA-861D video timing and Info Frame structure
- Hot plug and unplug detection and link status monitor
- Support DDC/CI and MCCS command transmission when the monitor includes a display controller.

1.2.16 Audio Interface

- I2S/PCM with 8ch
 - Up to 8 channels (4xTX, 2xRX)
 - Audio resolution from 16bits to 32bits

- Sample rate up to 192KHz
 - Provides master and slave work mode, software configurable
 - Support 3 I2S formats (normal, left-justified, right-justified)
 - Support 4 PCM formats(early, late1, late2, late3)
 - I2S and PCM mode cannot be used at the same time
- I2S/PCM with 2ch
 - Up to 2 channels (2xTX, 2xRX)
 - Audio resolution from 16bits to 32bits
 - Sample rate up to 192KHz
 - Provides master and slave work mode, software configurable
 - Support 3 I2S formats (normal, left-justified, right-justified)
 - Support 4 PCM formats(early, late1, late2, late3)
 - I2S and PCM mode cannot be used at the same time
- SPDIF
 - Support two 16-bit audio data store together in one 32-bit wide location
 - Support biphase format stereo audio data output
 - Support 16 to 31 bit audio data left or right justified in 32-bit wide sample data buffer
 - Support 16, 20, 24 bits audio data transfer in linear PCM mode
 - Support non-linear PCM transfer

1.2.17 Connectivity

- SDIO interface
 - Compatible with SDIO 3.0 protocol
 - 4bits data bus widths
- High-speed ADC stream interface
 - Support single-channel 8bits/10bits interface
 - DMA-based and interrupt-based operation
 - Support 8bits TS stream interface
- TS interface
 - Supports one TS input channels.
 - Supports 4 TS Input Mode: sync/valid mode in the case of serial TS input; nosync/valid mode, sync/valid, sync/burst mode in the case of parallel TS input.
 - Supports 2 TS sources: demodulators and local memory.
 - Supports 2 Built-in PTIs(Programmable Transport Interface) to process TS simultaneously, and Each PTI supports:
 - ◆ 64 PID filters.
 - ◆ TS descrambling with 16 sets of Control Word under CSA v2.0 standard, up to 104Mbps
 - ◆ 16 PES/ES filters with PTS/DTS extraction and ES start code detection.
 - ◆ 4/8 PCR extraction channels
 - ◆ 64 Section filters with CRC check, and three interrupt mode: stop per unit, full-stop, recycle mode with version number check
 - ◆ PID done and error interrupts for each channel
 - ◆ PCR/DTS/PTS extraction interrupt for each channel
 - Supports 1 PVR(Personal Video Recording) output channel.
 - 1 built-in multi-channel DMA Controller.
- Smart Card
 - support card activation and deactivation
 - support cold/warm reset
 - support Answer to Reset (ATR) response reception
 - support T0 for asynchronous half-duplex character transmission

- support T1 for asynchronous half-duplex block transmission
- support automatic operating voltage class selection
- support adjustable clock rate and bit (baud) rate
- support configurable automatic byte repetition
- GMAC 10/100/1000M Ethernet Controller
 - Supports 10/100/1000-Mbps data transfer rates with the RGMII interfaces
 - Supports 10/100-Mbps data transfer rates with the RMII interfaces
 - Supports both full-duplex and half-duplex operation
 - Preamble and start-of-frame data (SFD) insertion in Transmit, and deletion in Receive paths
 - Automatic CRC and pad generation controllable on a per-frame basis
 - Options for Automatic Pad/CRC Stripping on receive frames
 - Programmable Inter Frame Gap (40-96 bit times in steps of 8)
 - Supports a variety of flexible address filtering modes
 - Separate 32-bit status returned for transmission and reception packets
 - Supports IEEE 802.1Q VLAN tag detection for reception frames
 - Support detection of LAN wake-up frames and AMD Magic Packet frames
 - Support checksum off-load for received IPv4 and TCP packets encapsulated by the Ethernet frame
 - Support checking IPv4 header checksum and TCP, UDP, or ICMP checksum encapsulated in IPv4 or IPv6 datagrams
 - Comprehensive status reporting for normal operation and transfers with errors
 - Automatic generation of PAUSE frame control or backpressure signal to the GMAC core based on Receive FIFO-fill (threshold configurable) level
 - Handles automatic retransmission of Collision frames for transmission
 - Discards frames on late collision, excessive collisions, excessive deferral and under run conditions
- SPI Controller
 - 3 on-chip SPI controller inside RK3368
 - Support serial-master and serial-slave mode, software-configurable
 - DMA-based or interrupt-based operation
 - Embedded two 32x16bits FIFO for TX and RX operation respectively
 - Support 2 chip-selects output in serial-master mode
- Uart Controller
 - 5 on-chip uart controller inside RK3368
 - DMA-based or interrupt-based operation
 - For all UART, two 64Bytes FIFOs are embedded for TX/RX operation respectively
 - Support 5bit,6bit,7bit,8bit serial data transmit or receive
 - Standard asynchronous communication bits such as start, stop and parity
 - Support different input clock for uart operation to get up to 4Mbps or other special baud rate
 - Support non-integer clock divides for baud clock generation
 - Auto flow control mode is for all UART, except UART_DBG
- I2C controller
 - 6 on-chip I2C controller in RK3368
 - Multi-master I2C operation
 - Support 7bits and 10bits address mode
 - Software programmable clock frequency and transfer rate up to 400Kbit/s in the fast mode
 - Serial 8bits oriented and bidirectional data transfers can be made at up to 100Kbit/s in the standard mode
- GPIO

- Totally 128 GPIOs
 - All of GPIOs can be used to generate interrupt to Cortex-A53
 - GPIO0 can be used to wakeup system from low-power mode
 - The pull direction(pullup or pulldown) for all of GPIOs are software-programmable
 - All of GPIOs are always in input direction in default after power-on-reset
 - The drive strength for all of GPIOs is software-programmable
- USB Host2.0
 - Embedded 2 USB Host2.0 interfaces
 - Compatible with USB Host2.0 specification
 - Supports high-speed(480Mbps), full-speed(12Mbps) and low-speed (1.5Mbps) mode
 - Provides 16 host mode channels
 - Support periodic out channel in host mode
 - USB OTG2.0
 - Compatible with USB OTG2.0 specification
 - Supports high-speed(480Mbps), full-speed(12Mbps) and low-speed (1.5Mbps) mode
 - Support up to 9 device mode endpoints in addition to control endpoint 0
 - Support up to 6 device mode IN endpoints including control endpoint 0
 - Endpoints 1/3/5/7 can be used only as data IN endpoint
 - Endpoints 2/4/6 can be used only as data OUT endpoint
 - Endpoints 8/9 can be used as data OUT and IN endpoint
 - Provides 9 host mode channels

1.2.18 Others

- Temperature Sensor(TS-ADC)
 - 2 bipolar-based temperature-sensing cell embedded
 - 1-channel 8-bits SAR ADC
 - Temperature accuracy sensed is ± 5 degree
- SAR-ADC(Successive Approximation Register)
 - 3-channel single-ended 10-bit SAR analog-to-digital converter
 - Conversion speed range is up to 1 MSPS
 - SAR-ADC clock must be less than 1MHz
- eFuse
 - Two high-density electrical Fuse is integrated: 256bits (32x8) / 1024bits (32x32)
 - Support standby mode

Notes :^① DDR3/LPDDR2/LPDDR3 are not used simultaneously as well as async and sync ddr nand flash

^② In RK3368, Video decoder and encoder are not used simultaneously because of shared internal buffer

^③ Actual maximum frame rate will depend on the clock frequency and system bus performance

^④ Actual maximum data rate will depend on the clock frequency and JPEG compression rate

1.3 Block Diagram

The following diagram shows the basic block diagram for RK3368.

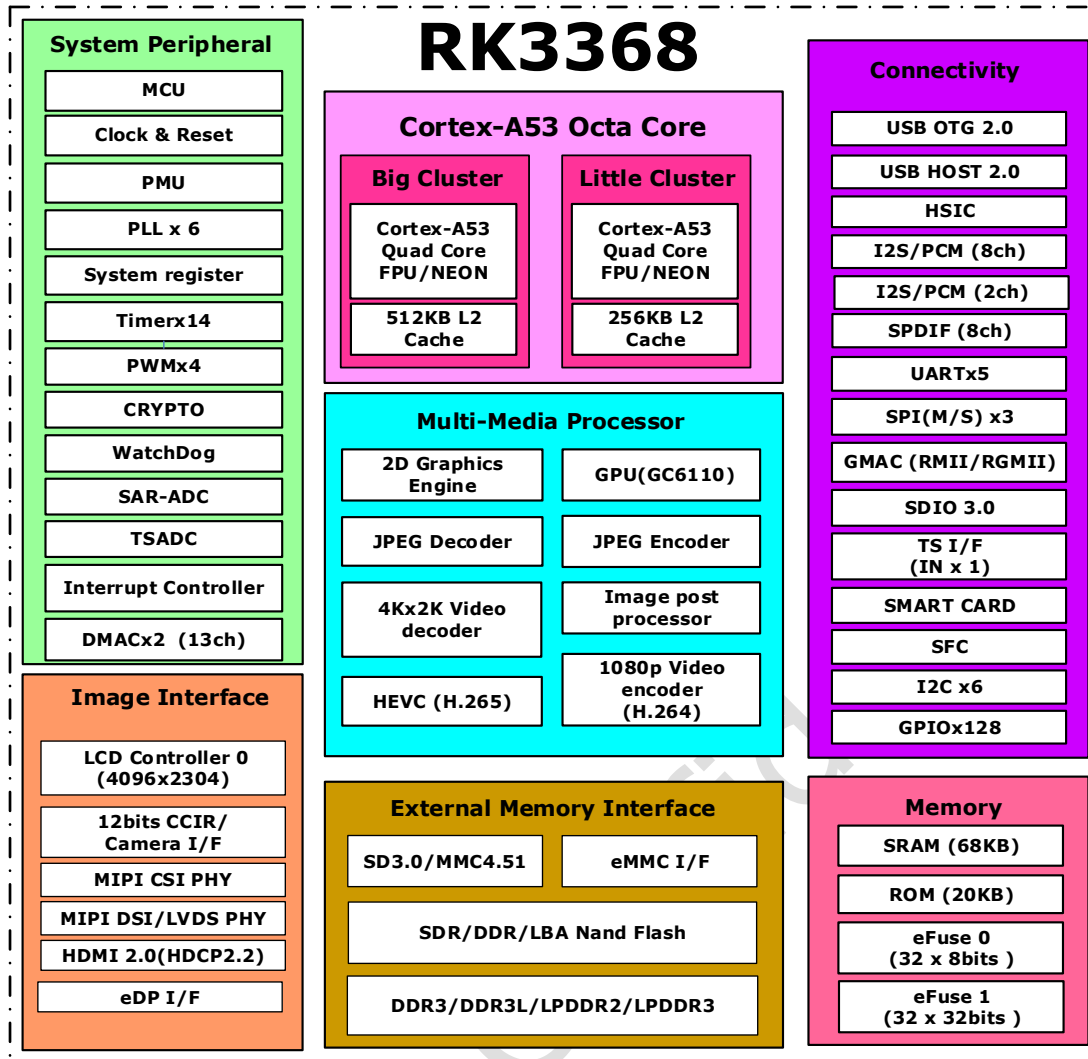


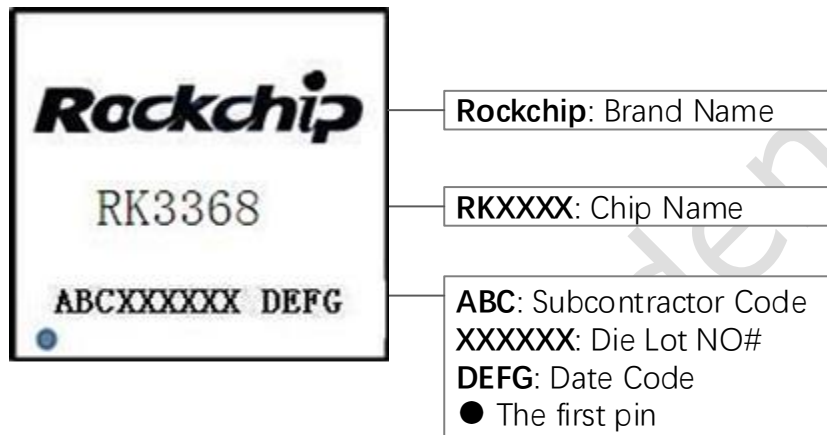
Fig. 1-1 RK3368 Block Diagram

Chapter 2 Package information

2.1 Ordering information

Orderable Device	RoHS status	Package	Package Qty	Device Feature
RK3368	Pb-Free	TFBGA453LD	700	Octa A53 Core AP

2.2 Top Marking



2.3 Dimension

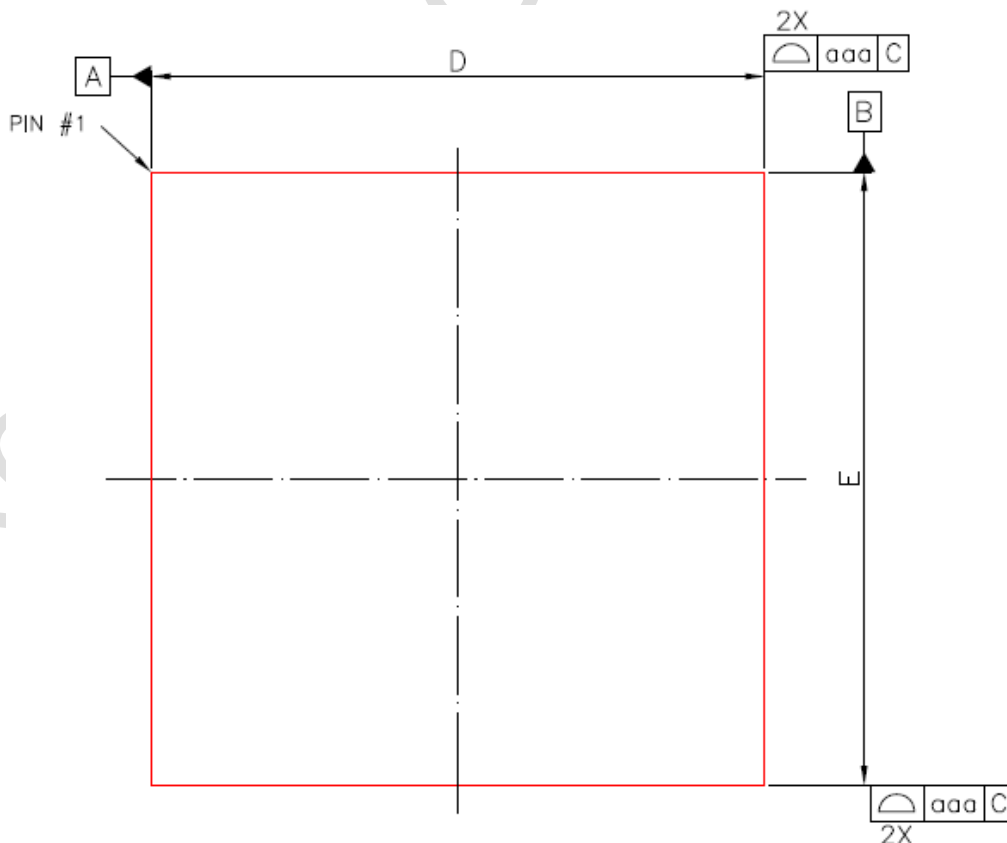


Fig. 2-1 RK3368 TFBGA453 Package Top View

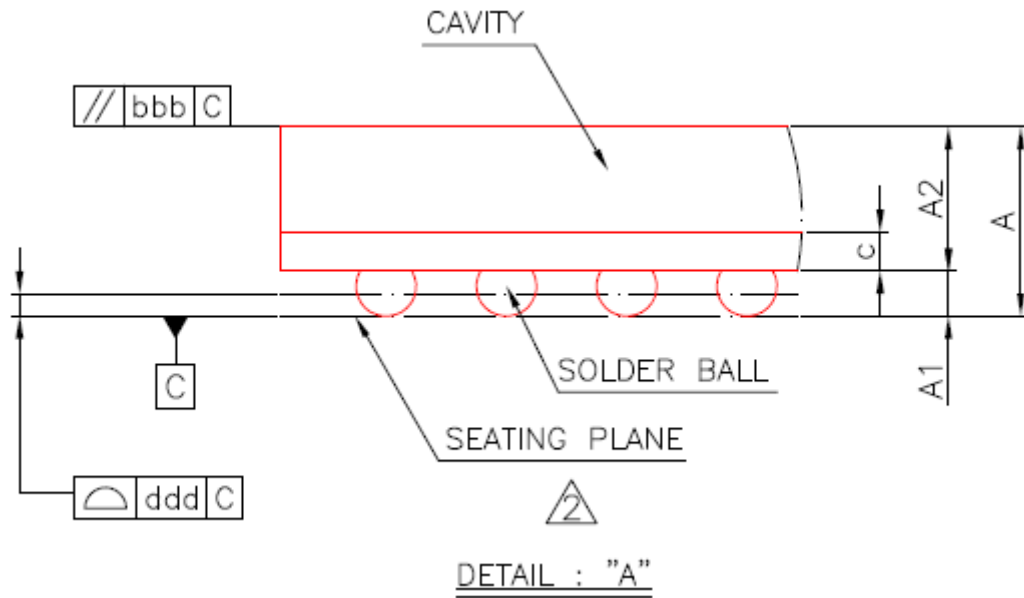


Fig. 2-2 RK3368 TFBGA453 Package Side View

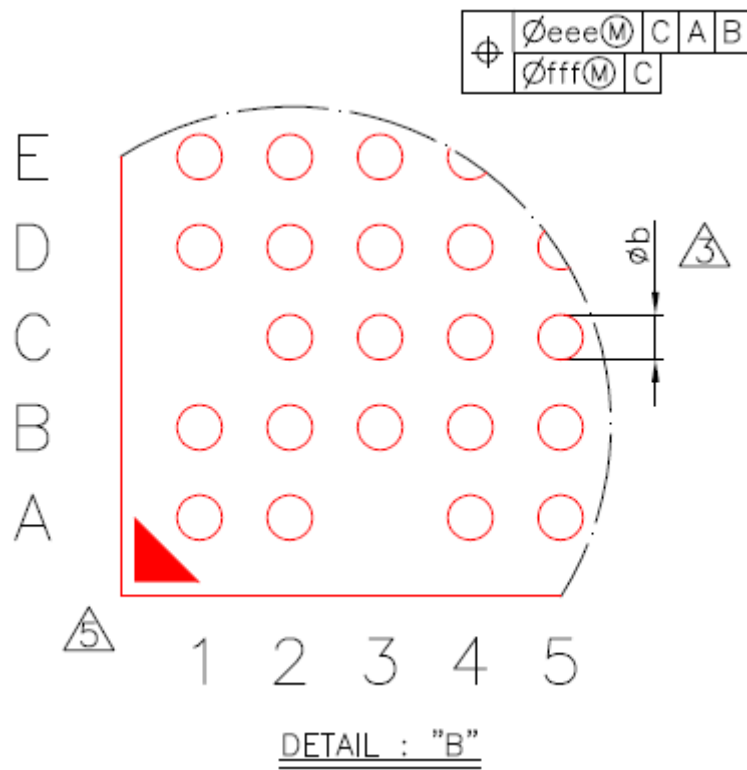


Fig. 2-3 RK3368 TFBGA453 Package Bottom View

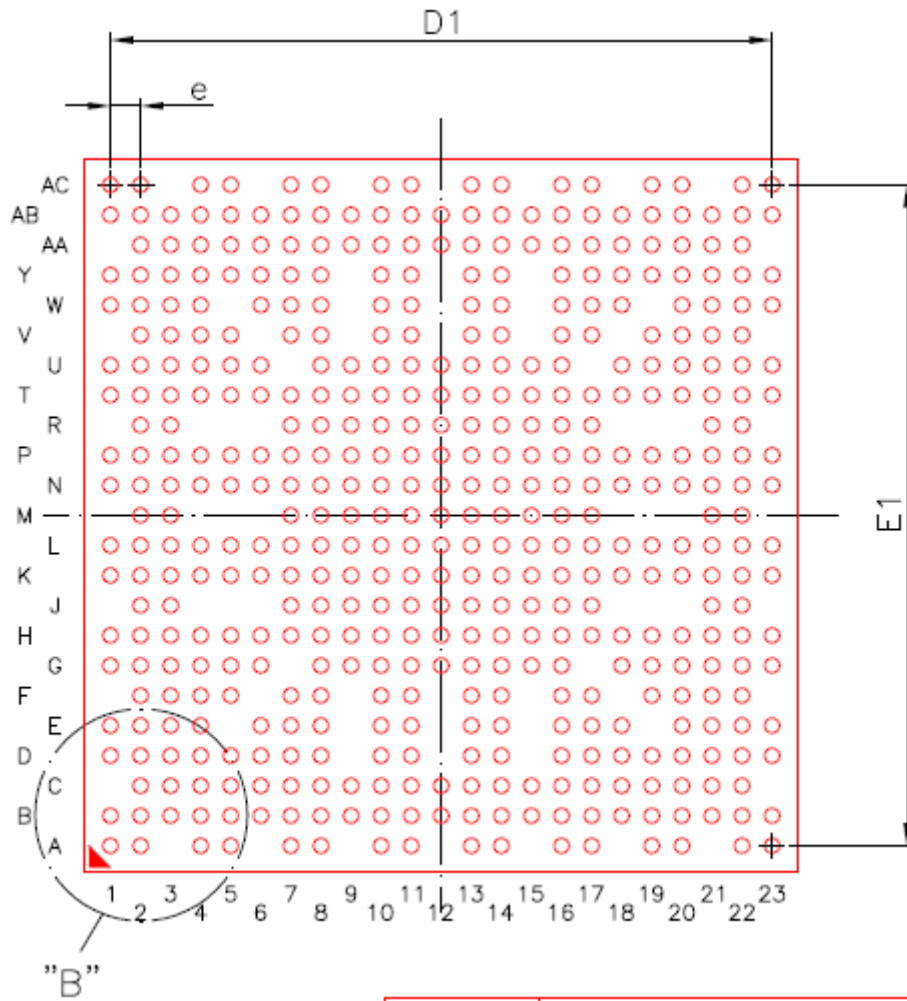


Fig. 2-4 RK3368 TFBGA453 Package Bottom View

Symbol	Dimension in mm			Dimension in inch		
	MIN	NOM	MAX	MIN	NOM	MAX
A	---	---	1.40	---	---	0.055
A1	0.25	0.30	0.35	0.010	0.012	0.014
A2	0.91	0.96	1.01	0.036	0.038	0.040
b	0.35	0.40	0.45	0.014	0.016	0.018
c	0.22	0.26	0.30	0.009	0.010	0.012
D	18.90	19.00	19.10	0.744	0.748	0.752
E	18.90	19.00	19.10	0.744	0.748	0.752
D1	---	17.60	---	---	0.693	---
E1	---	17.60	---	---	0.693	---
e	---	0.80	---	---	0.031	---
aaa	0.15			0.006		
bbb	0.20			0.008		
ddd	0.15			0.006		
eee	0.15			0.006		
fff	0.08			0.003		
MD/ME	23/23			23/23		

Fig. 2-5 RK3368 TFBGA453 Package Dimension

2.4 Ball Map

	1	2	3	4	5	6	7	8	9	10	11
A	GPIO1_C0/I2C3_SCL/SPI1_RXD	DDR_DM3		DDR_DQS3N	DDR_DQ31		DDR_DQS1N	DDR_CS0N		DDR_RA0SN	DDR_A0
B	GPIO1_B6/CIF_D10/SPI1_CLK	DDR_DQ24	DDR_DQ25	DDR_DQS3	DDR_DQ30	DDR_DQ10	DDR_DQS1	DDR_CKE1	DDR_CS1N	DDR_CA0SN	DDR_BA2
C		VSS_1	DDR_DQ26	DDR_DQ27	DDR_DQ29	DDR_DQ9	DDR_DQ12	DDR_DQ15	DDR_CKE0	DDR_WE0N	DDR_BA1
D	GPIO1_A6/CIF_D8/TS_D6	GPIO1_A7/CIF_D9/TS_D7	GPIO1_B5/CIF_D1	VSS_2	DDR_DQ28	DDR_DQ8	VSS_3	DDR_DQ14		VSS_4	DDR_BA0
E	GPIO1_B0/CIF_VSYNC/TS_SYNC	GPIO1_A4/CIF_D6/TS_D4	GPIO1_B4/CIF_D0	GPIO1_C1/I2C3_SDA/SPI1_TXD		DDR_DM1	DDR_DQ11	DDR_DQ13		DDR_RE0TEN_IN	DDR_RES0ETN
F		VSS_10	GPIO1_A5/CIF_D7/TS_D5	GPIO1_B1/CIF_HREF/TS_VALID	GPIO1_B7/CIF_D11/SPI1_CSN0		DDR_VDD_1	DDR_VDD_2		DDR_VDD_3	DDR_VDD_4
G	MIPI_CSI_DP0	MIPI_CSI_DN0	GPIO1_A2/CIF_D4/TS_D2	GPIO1_A3/CIF_D5/TS_D3	GPIO1_B3/CIF_CLKOUT/TS_FAIL	GPIO1_B2/CIF_CLKIN/TS_CLK		LOGIC_VDD_1	VSS_11	LOGIC_VDD_2	VSS_12
H	MIPI_CSI_DP1	MIPI_CSI_DN1	AVSS_1	GPIO1_A0/CIF_D2/TS_D0	GPIO1_A1/CIF_D3/TS_D1	MIPI_CSI_RBIAS	DVPIO_VDD	VSS_14	VSS_15	VSS_16	VSS_17
J		MIPI_CSI_CLKP	MIPI_CSI_CLKN				MIPI_CSI_AVDD_1V0	VSS_23	VSS_24	VSS_25	VSS_26
K	MIPI_CSI_DP2	MIPI_CSI_DN2	AVSS_2	LVDS/MIPI_AVDD_1V8	LVDS/MIPI_AVDD_1V0	MIPI_DSI_RBIAS	LVDS/MIPI_AVDD_3V3	VSS_32	VSS_33	VSS_34	VSS_35
L	MIPI_CSI_DP3	MIPI_CSI_DN3	AVSS_3	EDP_AVDD_1V0	EDP_RBIA0S	EDP_AVDD_1V8	EDP_CLKI_24M	VSS_41	VSS_42	VSS_43	VSS_44
M		MIPI_DSI_DN0/LCDC_D9/LVDS_DN0	MIPI_DSI_DP0/LCDC_D8/LVDS_DP0				EDP_DC_TP	VSS_50	VSS_51	VSS_52	VSS_53

12	13	14	15	16	17	18	19	20	21	22	23	
	DDR_CLK N	DDR_A5		DDR_A15	DDR_DQ18		DDR_DQS2 N	DDR_DQ19		DDR_DQS0N	DDR_DQ4	A
DDR_A2	DDR_CLK	DDR_A6	DDR_A11	DDR_A14	DDR_DQ17	DDR_DQ21	DDR_DQS2	DDR_DQ22	DDR_DQ23	DDR_DQS0	DDR_DQ5	B
DDR_A1	DDR_A4	DDR_A7	DDR_A10	DDR_A13	DDR_ODT1	DDR_DQ16	DDR_DQ20	DDR_DM2	VSS_8	DDR_DQ2		C
	VSS_5	DDR_A8		VSS_6	DDR_ODT0	DDR_A12	VSS_7	DDR_DM0	DDR_DQ1	DDR_DQ3	DDR_DQ6	D
	DDR_A3	DDR_A9		DDR_VDD _9	DDR_VDD_1 0	LOGIC_VDD _10		GPIO3_D7/SC _VCC18V/I2C2 _SDA/GPUJTA G_TCK	VSS_9	DDR_DQ0	DDR_DQ7	E
	DDR_VDD _5	DDR_V DD_6		DDR_VDD _7	DDR_VDD_8		GPIO2_C1/I 2S_SDO1/P CM_OUT	GPIO0_B1/SC _VCC33V/I2C2 _SCL/GPUJTA G_TRSTN	GPIO0_B2/SC _RST/SPI2_RX D/GPUJTAG_T MS	GPIO0_B5/SC _DETECT/SPI2 _CSN0/FLASH _VOL_SEL		F
LOGIC_VD D_3	DDRPLL_V DD_1V0	LOGIC_ VDD_4	VSS_13	LOGIC_VD D_5		APIO4_VDD	GPIO2_C5/I 2C1_SDA	GPIO2_C6/I2C 1_SCL	GPIO0_B3/SC _CLK/SPI2_TX D/GPUJTAG_T DI	GPIO0_B4/SC _IO/SPI2_CLK /GPUJTAG_TD O	GPIO2_C7/SP DIF_TX/EDP_ HPD	G
VSS_18	VSS_59	VSS_20	VSS_21	VSS_22	APIO3_VDD	GPIO2_D3/U ART0_RTSN	GPIO3_A7	GPIO2_B7/I2S _SDI	GPIO2_C3/I2S _SDO3/PCM_I N	GPIO2_C0/I2S _SDO0	GPIO2_C4/I2S _CLK	H
VSS_27	VSS_28	VSS_29	VSS_30	VSS_31	LOGIC_VDD _6				GPIO2_B6/I2S _LRCK_TX	GPIO2_C2/I2S _SDO2/PCM_C LK		J
VSS_36	VSS_37	VSS_38	VSS_39	VSS_40	APIO2_VDD	GPIO2_B4/I 2S_SCLK	GPIO2_D1/U ART0_TX	GPIO3_A6/SDI O0_INTN	GPIO2_D2/UA RT0_CTSN	GPIO2_D0/UA RT0_RX	GPIO2_B5/I2S _LRCK_RX/PC M_SYNC	K
VSS_45	VSS_46	VSS_47	VSS_48	VSS_49	GPIO3_A4/S DIO0_PWRE N	GPIO3_A2/S DIO0_DETE CTN	GPIO3_A1/S DIO0_CLKO UT	GPIO2_D7/SD IO0_D3	GPIO3_A0/SDI O0_CMD	GPIO3_A3/SDI O0_WRPRT	GPIO3_A5/SDI O0_BKPWR	L
VSS_54	VSS_55	VSS_56	VSS_57	VSS_58	LOGIC_VDD _7				GPIO2_B3/SD MMC0_DECTN	GPIO2_D4/SD IO0_D0		M

N	MIPI_DSI_DN1/LCDC_D7/LVDS_DN1	MIPI_DSI_DP1/LCDC_D6/LVDS_DP1	AVSS_4	HDMI_HPD	HDMI_RBIAS	HDMI_AVDD_1V8	HDMI_AVDD_1V0	LOGIC_VDD_9	VSS_60	VSS_61	VSS_62
P	MIPI_DSI_CLKN/LCDC_D5/LVDS_CLKN	MIPI_DSI_CLKP/LCDC_D4/LVDS_CLKP	VSS_95	GPIO0_C3/LCDC_D15/TRACE_D5/MCUJTAG_TDO	GPIO0_C0/LCD_C_D12/TRACE_D2/JTAG_TDO	GPIO0_C1/LCDC_D13/TRACE_D3/MCUJTAG_TRSTN	TEST	VSS_68	VSS_69	VSS_70	VSS_71
R		MIPI_DSI_DN2/LCDC_D2/LVDS_DN2	MIPI_DSI_DP2/LCDC_D3/LVDS_DP2				PMU_VDD_1V0	VSS_77	VSS_78	VSS_79	VSS_80
T	MIPI_DSI_DN3/LCDC_D0/LVDS_DN3	MIPI_DSI_DP3/LCDC_D1/LVDS_DP3	AVSS_5	LCDC_VDD_2	LCDC_VDD_1	PMUIO_VDD	ADC_AVDD_1V8	LOGIC_VDD_COM	VSS_87	VSS_88	VSS_89
U	EDP_TX0P	EDP_TX0N	VSS_96	GPIO0_B6/LCDC_D10/TRACE_D0/JTAG_TRSTN	GPIO0_C4/LCD_C_D16/TRACE_D6/UART1_RX	GPIO0_D0/LCDC_D20/TRACE_D10/UART4_CTSN	APLL_AVSS	CPU_VDD_D_1	CPU_VDD_D_2	CPU_VDD_D_3	
V		EDP_TX1P	EDP_TX1N	GPIO0_B7/LCDC_D11/TRACE_D1/JTAG_TDI	GPIO0_C6/LCD_C_D18/TRACE_D8/UART1_CTSN		G/LL_AVSS	C/DPLL_AVSS		CPU_VDD_D_9	CPU_VDD_D_10
W	EDP_TX2P	EDP_TX2N	AVSS_6	GPIO0_C2/LCDC_D14/TRACE_D4/MCUJTAG_TDI		GPIO0_D4/LCDC_HSVCN/TRACE_D14/PMU_DEBUG2	C/DPLL_AVDD_1V0	G/LL_AVDD_1V0		CPU_VDD_D_14	CPU_VDD_D_15
Y	EDP_TX3P	EDP_TX3N	VSS_97	GPIO0_C5/LCDC_D17/TRACE_D7/UART1_TX	GPIO0_D2/LCD_C_D22/TRACE_D12/UART4_TX	GPIO0_C7/LCDC_D19/TRACE_D9/UART1_RTSN	GPIO0_D3/LCDC_D23/TRACE_D13/UART4_RX	APLL_AVDD_1V0		EFUSE_VQPS	GPIO0_A7/I2C0_SCL
AA		EDP_AUXP	EDP_AUXN	VSS_98	AVSS_8	GPIO0_D1/LCDC_D21/TRACE_D11/UART4_RTSN	GPIO0_D7/LCDC_DCLK/TRACE_CTL/PMU_DEBUG5	GPIO0_A4	CLK32K/PWM2	XVSS	ADC_IN0
AB	HDMI_TCP	HDMI_TX0P	AVSS_7	HDMI_TX1P	HDMI_TX2P	VSS_99	GPIO0_D6/LCDC_DEN/TRACE_CLK/PMU_DEBUG4	GPIO0_A2	VSS_100	OSC_24M_OUT	ADC_IN2
AC	HDMI_TCN	HDMI_TX0N		HDMI_TX1N	HDMI_TX2N		GPIO0_D5/LCDC_VSYNC/TRACE_D15/PMU_DEBUG3	OR		OSC_24M_IN	ADC_IN1
	1	2	3	4	5	6	7	8	9	10	11

VSS_6 3	VSS_64	VSS_65	VSS_66	VSS_67	APIO1_VD D	GPIO3_D0/ MAC_MDIO /I2C4_SDA	GPIO2_B2/S DMMC0_CM D/MCUJTAG _TMS	GPIO2_ D5/SDI O0_D1	SDMMC_VDD	GPIO2_B1/ SDMMC0_C LKOUT/MCU JTAG_TCK	GPIO2_D6/ SDIO0_D2	N
VSS_7 2	VSS_73	VSS_74	VSS_75	VSS_76	USB_AVDD _3V3	GPIO2_A5/ SDMMC0_ D0/UART2 _TX	GPIO3_D5/I R_RX/UART3 _RX	VSS_94	GPIO3_C5/MAC _RXER/ISP_PR ELIGHTTRIG	GPIO2_A6/ SDMMC0_D 1/UART2_R X	GPIO2_B0/ SDMMC0_D 3/JTAG_TM S	P
VSS_8 1	VSS_82	VSS_83	VSS_84	VSS_85	USB_RBIA S				GPIO3_D6/IR TX/UART3_TX/ PWM3/IR_REM OTE_IN	GPIO2_A7/ SDMMC0_D 2/JTAG_TC K		R
VSS_9 0	VSS_91	VSS_92	VSS_93	CPU_VDD_ COM	LOGIC_VD D_8	GPIO3_B0/ MAC_TXD0 /PWM0/VO P_PWM	GPIO3_B6/M AC_TXD3/GP S_MAG	GPIO3_ B2/MAC _TXD2	GPIO3_C1/MAC _RXD2/UART3_ RTSN/USB_DR VVBUS0	GPIO3_D2/ HDMI_I2C_ SDA/I2C5_ SDA	GPIO3_D3/ HDMI_I2C_ SCL/I2C5_S CL	T
CPU_V DD_4	CPU_VDD _5	CPU_VDD_ 6	CPU_VDD _7	CPU_VDD_ 8		GPIO3_D1/ MAC_RXCL KIN/I2C4_ SCL	GPIO3_B1/M AC_TXD1	VSS_19	GPIO3_C0/MAC _RXD1/UART3_ CTSN/GPS_RFC LK	GPIO3_C3/ MAC_MDC/I SP_SHUTTE REN	GPIO3_C7/ EDPHDMI_C EC/ISP_FL SHTRIGIN	U
	CPU_VDD _11	CPU_VDD_ 12		CPU_VDD_ 13	FLASH_VD D		GPIO3_B5/M AC_TXEN	USB_AV DD_1V8	USB_AVDD_1V 0	GPIO3_B3/ MAC_CRS		V
	CPU_VDD _16	CPU_VDD_ 17		CPU_VDD_ 18	GPIO1_D5/ FLASH_AL E/SPI0_CL K	GPIO1_C5/ FLASH_D3 /EMMC_D3 /SFC_SIO3		GPIO3_ D4/MAC _TX_CL KO/SPI1 _CSN1	GPIO3_C6/MAC _CLK/ISP_SHU TTERTRIG	GPIO3_C4/ MAC_RXDV /ISP_FLASH TRIGOUT	GPIO3_B4/ MAC_COL	W
	CPU_VDD _19	CPU_VDD_ 20		GPIO2_A3/ FLASH_CS N3/EMMC_ RSTNOUT	GPIO1_D7/ FLASH_WR N/SFC_CS N0	GPIO1_C6/ FLASH_D4 /EMMC_D4 /SPI0_RXD	GPIO1_D0/F LASH_D6/EM MC_D6/SPI0 _CSN0	USB0_I D	HSIC_AVDD_1 V2	VSS_86	GPIO3_C2/ MAC_RXD3/ USB_DRVV BUS1	Y
GPIO0 _A1	GPIO0_A6 /I2C0_SD A	GPIO2_A1 /FLASH_C SN1	GPIO2_A4 /FLASH_D QS/EMMC _CLKOUT	GPIO2_A0/ FLASH_CS N0	GPIO1_C3/ FLASH_D1 /EMMC_D1 /SFC_SIO1	GPIO1_C4/ FLASH_D2 /EMMC_D2 /SFC_SIO2	GPIO1_D1/F LASH_D7/EM MC_D7/SPI0 _CSN1	USB_AV SS_1	USB_VBUS	USB_AVSS_ 2		A A
DDR_ RETEN _OUT	GPIO0_A3 /OTP_OUT GPIO0_A5 /PMU_DEB UG0	GPIO2_A2 /FLASH_C SN2	GPIO2_D3/ FLASH_WP/ EMMC_PWR EN	GPIO1_D4/ FLASH_RD N/SFC_CS N1	GPIO1_C2/ FLASH_D0 /EMMC_D0 /SFC_SIO0	GPIO3_B7/M AC_RXD0/GP S_SIG	HSIC_D ATA	USB_AVSS_3	USB0_DP	USB1_DP		A B
	GPIO0_B0 /TEST_CL KOUT/PW M_1/PMU_ DEBUG1	GPIO0_A0 /GLOBAL_ PWROFF/P MIC_SLEE P		GPIO1_D2/ FLASH_RDY /EMMC_CM D/SFC_CLK	GPIO1_D6/ FLASH_CL E		GPIO1_C7/F LASH_D5/EM MC_D5/SPI0 _TXD	HSIC_S TROBE		USB0_DM	USB1_DM	A C
12	13	14	15	16	17	18	19	20	21	22	23	

Fig. 2-6 RK3368 Ball Mapping Diagram

2.5 Pin List

Table 2-1 RK3368 Pin List

A1	GPIO1_C0/I2C3_SCL/SPI1_RXD	B1	GPIO1_B6/CIF_D10/SPI1_CLK
A2	DDR_DM3	B2	DDR_DQ24
A4	DDR_DQS3N	B3	DDR_DQ25
A5	DDR_DQ31	B4	DDR_DQS3
A7	DDR_DQS1N	B5	DDR_DQ30
A8	DDR_CS0N	B6	DDR_DQ10
A10	DDR_RASN	B7	DDR_DQS1
A11	DDR_A0	B8	DDR_CKE1
A13	DDR_CLKN	B9	DDR_CS1N
A14	DDR_A5	B10	DDR_CASN
A16	DDR_A15	B11	DDR_BA2
A17	DDR_DQ18	B12	DDR_A2
A19	DDR_DQS2N	B13	DDR_CLK
A20	DDR_DQ19	B14	DDR_A6
A22	DDR_DQS0N	B15	DDR_A11
A23	DDR_DQ4	B16	DDR_A14
C2	VSS_1	B17	DDR_DQ17
C3	DDR_DQ26	B18	DDR_DQ21
C4	DDR_DQ27	B19	DDR_DQS2
C5	DDR_DQ29	B20	DDR_DQ22
C6	DDR_DQ9	B21	DDR_DQ23
C7	DDR_DQ12	B22	DDR_DQS0
C8	DDR_DQ15	B23	DDR_DQ5
C9	DDR_CKE0	D1	GPIO1_A6/CIF_D8/TS_D6
C10	DDR_WEN	D2	GPIO1_A7/CIF_D9/TS_D7
C11	DDR_BA1	D3	GPIO1_B5/CIF_D1
C12	DDR_A1	D4	VSS_2
C13	DDR_A4	D5	DDR_DQ28
C14	DDR_A7	D6	DDR_DQ8
C15	DDR_A10	D7	VSS_3
C16	DDR_A13	D8	DDR_DQ14
C17	DDR_ODT1	D10	VSS_4
C18	DDR_DQ16	D11	DDR_BA0
C19	DDR_DQ20	D13	VSS_5
C20	DDR_DM2	D14	DDR_A8
C21	VSS_8	D16	VSS_6
C22	DDR_DQ2	D17	DDR_ODT0
E1	GPIO1_B0/CIF_VSYNC/TS_SYNC	D18	DDR_A12
E2	GPIO1_A4/CIF_D6/TS_D4	D19	VSS_7
E3	GPIO1_B4/CIF_D0	D20	DDR_DM0

E4	GPIO1_C1/I2C3_SDA/SPI1_TXD	D21	DDR_DQ1
E6	DDR_DM1	D22	DDR_DQ3
E7	DDR_DQ11	D23	DDR_DQ6
E8	DDR_DQ13	F2	VSS_10
E10	DDR_RETEN_IN	F3	GPIO1_A5/CIF_D7/TS_D5
E11	DDR_RESETN	F4	GPIO1_B1/CIF_HREF/TS_VALID
E13	DDR_A3	F5	GPIO1_B7/CIF_D11/SPI1_CSNO
E14	DDR_A9	F7	DDR_VDD_1
E16	DDR_VDD_9	F8	DDR_VDD_2
E17	DDR_VDD_10	F10	DDR_VDD_3
E18	LOGIC_VDD_10	F11	DDR_VDD_4
E20	GPIO3_D7/SC_VCC18V/I2C2_SDA/GPUJTAG_TCK	F13	DDR_VDD_5
E21	VSS_9	F14	DDR_VDD_6
E22	DDR_DQ0	F16	DDR_VDD_7
E23	DDR_DQ7	F17	DDR_VDD_8
G1	MIPI_CSI_DP0	F19	GPIO2_C1/I2S_SDO1/PCM_OUT
G2	MIPI_CSI_DN0	F20	GPIO0_B1/SC_VCC33V/I2C2_SCL/GPUJTAG_TRSTN
G3	GPIO1_A2/CIF_D4/TS_D2	F21	GPIO0_B2/SC_RST/SPI2_RXD/GPUJTAG_TMS
G4	GPIO1_A3/CIF_D5/TS_D3	F22	GPIO0_B5/SC_DETECT/SPI2_CSNO/FLASH_VOLSEL
G5	GPIO1_B3/CIF_CLKOUT/TS_FAIL	H1	MIPI_CSI_DP1
G6	GPIO1_B2/CIF_CLKIN/TS_CLK	H2	MIPI_CSI_DN1
G8	LOGIC_VDD_1	H3	AVSS_1
G9	VSS_11	H4	GPIO1_A0/CIF_D2/TS_D0
G10	LOGIC_VDD_2	H5	GPIO1_A1/CIF_D3/TS_D1
G11	VSS_12	H6	MIPI_CSI_RBIAS
G12	LOGIC_VDD_3	H7	DVPIO_VDD
G13	DDRPLL_VDD_1V0	H8	VSS_14
G14	LOGIC_VDD_4	H9	VSS_15
G15	VSS_13	H10	VSS_16
G16	LOGIC_VDD_5	H11	VSS_17
G18	APIO4_VDD	H12	VSS_18
G19	GPIO2_C5/I2C1_SDA	H13	VSS_59
G20	GPIO2_C6/I2C1_SCL	H14	VSS_20
G21	GPIO0_B3/SC_CLK/SPI2_TXD/GPUJTAG_TDI	H15	VSS_21
G22	GPIO0_B4/SC_IO/SPI2_CLK/GPUJTAG_TDO	H16	VSS_22
G23	GPIO2_C7/SPDIF_TX/EDP_HPD	H17	APIO3_VDD
J2	MIPI_CSI_CLKP	H18	GPIO2_D3/UART0_RTSEN

J3	MIPI_CSI_CLKN	H19	GPIO3_A7
J7	MIPI_CSI_AVDD_1V0	H20	GPIO2_B7/I2S_SDI
J8	VSS_23	H21	GPIO2_C3/I2S_SDO3/PCM_IN
J9	VSS_24	H22	GPIO2_C0/I2S_SDO0
J10	VSS_25	H23	GPIO2_C4/I2S_CLK
J11	VSS_26	K1	MIPI_CSI_DP2
J12	VSS_27	K2	MIPI_CSI_DN2
J13	VSS_28	K3	AVSS_2
J14	VSS_29	K4	LVDS/MIPI_AVDD_1V8
J15	VSS_30	K5	LVDS/MIPI_AVDD_1V0
J16	VSS_31	K6	MIPI_DSI_RBIAS
J17	LOGIC_VDD_6	K7	LVDS/MIPI_AVDD_3V3
J21	GPIO2_B6/I2S_LRCK_TX	K8	VSS_32
J22	GPIO2_C2/I2S_SDO2/PCM_CLK	K9	VSS_33
L1	MIPI_CSI_DP3	K10	VSS_34
L2	MIPI_CSI_DN3	K11	VSS_35
L3	AVSS_3	K12	VSS_36
L4	EDP_AVDD_1V0	K13	VSS_37
L5	EDP_RBIAS	K14	VSS_38
L6	EDP_AVDD_1V8	K15	VSS_39
L7	EDP_CLKI_24M	K16	VSS_40
L8	VSS_41	K17	APIO2_VDD
L9	VSS_42	K18	GPIO2_B4/I2S_SCLK
L10	VSS_43	K19	GPIO2_D1/UART0_TX
L11	VSS_44	K20	GPIO3_A6/SDIO0_INTN
L12	VSS_45	K21	GPIO2_D2/UART0_CTSN
L13	VSS_46	K22	GPIO2_D0/UART0_RX
L14	VSS_47	K23	GPIO2_B5/I2S_LRCK_RX/PCM_SYNC
L15	VSS_48	M2	MIPI_DSI_DN0/LCDC_D9/LVDS_DN0
L16	VSS_49	M3	MIPI_DSI_DP0/LCDC_D8/LVDS_DP0
L17	GPIO3_A4/SDIO0_PWREN	M7	EDP_DC_TP
L18	GPIO3_A2/SDIO0_DETECTN	M8	VSS_50
L19	GPIO3_A1/SDIO0_CLKOUT	M9	VSS_51
L20	GPIO2_D7/SDIO0_D3	M10	VSS_52
L21	GPIO3_A0/SDIO0_CMD	M11	VSS_53
L22	GPIO3_A3/SDIO0_WRPRT	M12	VSS_54
L23	GPIO3_A5/SDIO0_BKPWR	M13	VSS_55
N1	MIPI_DSI_DN1/LCDC_D7/LVDS_DN1	M14	VSS_56
N2	MIPI_DSI_DP1/LCDC_D6/LVDS_DP1	M15	VSS_57
N3	AVSS_4	M16	VSS_58

N4	HDMI_HPD	M17	LOGIC_VDD_7
N5	HDMI_RBIAS	M21	GPIO2_B3/SDMMC0_DECTN
N6	HDMI_AVDD_1V8	M22	GPIO2_D4/SDIO0_D0
N7	HDMI_AVDD_1V0	P1	MIPI_DSI_CLKN/LCDC_D5/LVDS_CLKN
N8	LOGIC_VDD_9	P2	MIPI_DSI_CLKP/LCDC_D4/LVDS_CLKP
N9	VSS_60	P3	VSS_95
N10	VSS_61	P4	GPIO0_C3/LCDC_D15/TRACE_D5/MCUJTAG_TDO
N11	VSS_62	P5	GPIO0_C0/LCDC_D12/TRACE_D2/JTAG_TDO
N12	VSS_63	P6	GPIO0_C1/LCDC_D13/TRACE_D3/MCUJTAG_TRS TN
N13	VSS_64	P7	TEST
N14	VSS_65	P8	VSS_68
N15	VSS_66	P9	VSS_69
N16	VSS_67	P10	VSS_70
N17	APIO1_VDD	P11	VSS_71
N18	GPIO3_D0/MAC_MDIO/I2C4_SDA	P12	VSS_72
N19	GPIO2_B2/SDMMC0_CMD/MCUJTAG_TMS	P13	VSS_73
N20	GPIO2_D5/SDIO0_D1	P14	VSS_74
N21	SDMMC_VDD	P15	VSS_75
N22	GPIO2_B1/SDMMC0_CLKOUT/MCUJTAG_TCK	P16	VSS_76
N23	GPIO2_D6/SDIO0_D2	P17	USB_AVDD_3V3
R2	MIPI_DSI_DN2/LCDC_D2/LVDS_DN2	P18	GPIO2_A5/SDMMC0_D0/UART2_TX
R3	MIPI_DSI_DP2/LCDC_D3/LVDS_DP2	P19	GPIO3_D5/IR_RX/UART3_RX
R7	PMU_VDD_1V0	P20	VSS_94
R8	VSS_77	P21	GPIO3_C5/MAC_RXER/ISP_PRELIGHTTRIG
R9	VSS_78	P22	GPIO2_A6/SDMMC0_D1/UART2_RX
R10	VSS_79	P23	GPIO2_B0/SDMMC0_D3/JTAG_TMS
R11	VSS_80	T1	MIPI_DSI_DN3/LCDC_D0/LVDS_DN3
R12	VSS_81	T2	MIPI_DSI_DP3/LCDC_D1/LVDS_DP3
R13	VSS_82	T3	AVSS_5
R14	VSS_83	T4	LCDC_VDD_2
R15	VSS_84	T5	LCDC_VDD_1
R16	VSS_85	T6	PMUIO_VDD
R17	USB_RBIAS	T7	ADC_AVDD_1V8
R21	GPIO3_D6/IR_TX/UART3_TX/PWM3/IR_REMOTE _IN	T8	LOGIC_VDD_COM
R22	GPIO2_A7/SDMMC0_D2/JTAG_TCK	T9	VSS_87
U1	EDP_TX0P	T10	VSS_88
U2	EDP_TX0N	T11	VSS_89

U3	VSS_96	T12	VSS_90
U4	GPIO0_B6/LCDC_D10/TRACE_D0/JTAG_TRSTN	T13	VSS_91
U5	GPIO0_C4/LCDC_D16/TRACE_D6/UART1_RX	T14	VSS_92
U6	GPIO0_D0/LCDC_D20/TRACE_D10/UART4_CTS N	T15	VSS_93
U8	APLL_AVSS	T16	CPU_VDD_COM
U9	CPU_VDD_1	T17	LOGIC_VDD_8
U10	CPU_VDD_2	T18	GPIO3_B0/MAC_TXD0/PWM0/VOP_PWM
U11	CPU_VDD_3	T19	GPIO3_B6/MAC_TXD3/GPS_MAG
U12	CPU_VDD_4	T20	GPIO3_B2/MAC_TXD2
U13	CPU_VDD_5	T21	GPIO3_C1/MAC_RXD2/UART3_RTSN/USB_DRVVB US0
U14	CPU_VDD_6	T22	GPIO3_D2/HDMI_I2C_SDA/I2C5_SDA
U15	CPU_VDD_7	T23	GPIO3_D3/HDMI_I2C_SCL/I2C5_SCL
U16	CPU_VDD_8	V2	EDP_TX1P
U18	GPIO3_D1/MAC_RXCLKIN/I2C4_SCL	V3	EDP_TX1N
U19	GPIO3_B1/MAC_TXD1	V4	GPIO0_B7/LCDC_D11/TRACE_D1/JTAG_TDI
U20	VSS_19	V5	GPIO0_C6/LCDC_D18/TRACE_D8/UART1_CTSN
U21	GPIO3_C0/MAC_RXD1/UART3_CTSN/GPS_RFCL K	V7	G/NPLL_AVSS
U22	GPIO3_C3/MAC_MDC/ISP_SHUTTEREN	V8	C/DPLL_AVSS
U23	GPIO3_C7/EDPHDMI_CEC/ISP_FLASHTRIGIN	V10	CPU_VDD_9
W1	EDP_TX2P	V11	CPU_VDD_10
W2	EDP_TX2N	V13	CPU_VDD_11
W3	AVSS_6	V14	CPU_VDD_12
W4	GPIO0_C2/LCDC_D14/TRACE_D4/MCUJTAG_TDI	V16	CPU_VDD_13
W6	GPIO0_D4/LCDC_HSYNC/TRACE_D14/PMU_DEB UG2	V17	FLASH_VDD
W7	C/DPLL_AVDD_1V0	V19	GPIO3_B5/MAC_TXEN
W8	G/NPLL_AVDD_1V0	V20	USB_AVDD_1V8
W10	CPU_VDD_14	V21	USB_AVDD_1V0
W11	CPU_VDD_15	V22	GPIO3_B3/MAC_CRS
W13	CPU_VDD_16	Y1	EDP_TX3P
W14	CPU_VDD_17	Y2	EDP_TX3N
W16	CPU_VDD_18	Y3	VSS_97
W17	GPIO1_D5/FLASH_ALE/SPI0_CLK	Y4	GPIO0_C5/LCDC_D17/TRACE_D7/UART1_TX
W18	GPIO1_C5/FLASH_D3/EMMC_D3/SFC_SIO3	Y5	GPIO0_D2/LCDC_D22/TRACE_D12/UART4_TX
W20	GPIO3_D4/MAC_TX_CLKO/SPI1_CSN1	Y6	GPIO0_C7/LCDC_D19/TRACE_D9/UART1_RTSN
W21	GPIO3_C6/MAC_CLK/ISP_SHUTTERTRIG	Y7	GPIO0_D3/LCDC_D23/TRACE_D13/UART4_RX

W22	GPIO3_C4/MAC_RXDV/ISP_FLASHTRIGOUT	Y8	APLL_AVDD_1V0
W23	GPIO3_B4/MAC_COL	Y10	EFUSE_VQPS
AA2	EDP_AUXP	Y11	GPIO0_A7/I2C0_SCL
AA3	EDP_AUXN	Y13	CPU_VDD_19
AA4	VSS_98	Y14	CPU_VDD_20
AA5	AVSS_8	Y16	GPIO2_A3/FLASH_CSN3/EMMC_RSTNOUT
AA6	GPIO0_D1/LCDC_D21/TRACE_D11/UART4_RT N	Y17	GPIO1_D7/FLASH_WRN/SFC_CSN0
AA7	GPIO0_D7/LCDC_DCLK/TRACE_CTL/PMU_DEBU G5	Y18	GPIO1_C6/FLASH_D4/EMMC_D4/SPI0_RXD
AA8	GPIO0_A4	Y19	GPIO1_D0/FLASH_D6/EMMC_D6/SPI0_CSN0
AA9	CLK32K/PWM2	Y20	USB0_ID
AA10	XVSS	Y21	USIC_AVDD_1V2
AA11	ADC_IN0	Y22	VSS_86
AA12	GPIO0_A1	Y23	GPIO3_C2/MAC_RXD3/USB_DRVBUS1
AA13	GPIO0_A6/I2C0_SDA	AB1	HDMI_TCP
AA14	GPIO2_A1/FLASH_CSN1	AB2	HDMI_TX0P
AA15	GPIO2_A4/FLASH_DQS/EMMC_CLKOUT	AB3	AVSS_7
AA16	GPIO2_A0/FLASH_CSN0	AB4	HDMI_TX1P
AA17	GPIO1_C3/FLASH_D1/EMMC_D1/SFC_SIO1	AB5	HDMI_TX2P
AA18	GPIO1_C4/FLASH_D2/EMMC_D2/SFC_SIO2	AB6	VSS_99
AA19	GPIO1_D1/FLASH_D7/EMMC_D7/SPI0_CSN1	AB7	GPIO0_D6/LCDC_DEN/TRACE_CLK/PMU_DEBUG4
AA20	USB_AVSS_1	AB8	GPIO0_A2
AA21	USB_VBUS	AB9	VSS_100
AA22	USB_AVSS_2	AB10	OSC_24M_OUT
AC1	HDMI_TCN	AB11	ADC_IN2
AC2	HDMI_TX0N	AB12	DDR_RETEN_OUT
AC4	HDMI_TX1N	AB13	GPIO0_A5
AC5	HDMI_TX2N	AB14	GPIO0_A3/OTP_OUT/PMU_DEBUG0
AC7	GPIO0_D5/LCDC_VSYNC/TRACE_D15/PMU_DEB UG3	AB15	GPIO2_A2/FLASH_CSN2
AC8	NPOR	AB16	GPIO1_D3/FLASH_WP/EMMC_PWREN
AC10	OSC_24M_IN	AB17	GPIO1_D4/FLASH_RDN/SFC_CSN1
AC11	ADC_IN1	AB18	GPIO1_C2/FLASH_D0/EMMC_D0/SFC_SIO0
AC14	GPIO0_A0/GLOBAL_PWROFF/PMIC_SLEEP	AB19	GPIO3_B7/MAC_RXD0/GPS_SIG
AC16	GPIO1_D2/FLASH_RDY/EMMC_CMD/SFC_CLK	AB20	USIC_DATA
AC17	GPIO1_D6/FLASH_CLE	AB21	USB_AVSS_3
AC19	GPIO1_C7/FLASH_D5/EMMC_D5/SPI0_TXD	AB22	USB0_DP
AC20	USIC_STROBE	AB23	USB1_DP

AC22	USB0_DM	AC13	GPIO0_B0/TEST_CLKOUT/PWM_1/PMU_DEBUG1
AC23	USB1_DM		

2.6 Power/ground Pin Descriptions

Table 2-2 RK3368 Power/Ground Pin Description

Group	Ball #	Descriptions
VSS	AA10 C2 C21 E21 G9 G11 G15 J8 J9 J10 J11 J12 J13 J14 J15 J16 L8 L9 L10 L11 L12 L13 L14 L15 L16 N9 N10 N11 N12 N13 N14 N15 N16 R8 R9 R10 R11 R12 R13 R14 R15 R16 U3 U20 AA4 D4 D7 D10 D13 D16 D19 F2 H8 H9 H10 H11 H12 H13 H14 H15 H16 K8 K9 K10 K11 K12 K13 K14 K15 K16 M8 M9 M10 M11 M12 M13 M14 M15 M16 P3 P8 P9 P10 P11 P12 P13 P14 P15 P16 P20 T9 T10 T11 T12 T13 T14 T15 Y3 Y22 AB6 AB9	Internal Logic Ground and Digital IO Ground
CPU_VDD	U9 U10 U11 U12 U13 U14 U15 U16 W10 W11 W13 W14 W16 T16 V10 V11 V13 V14 V16 Y13 Y14	Internal CPU Power (@ cpu frequency <= 900MHz)
		Internal CPU Power (@ cpu frequency <= 1.5GHz)
LOGIC_VDD	E18 G8 G10 G12 G14 G16 J17 N8 M17 T8 T17	Internal Logic Power
DDR_VDD	E16 E17 F7 F8 F10 F11 F13 F14 F16 F17	DDR3 Digital IO Power LPDDR2 Digital IO Power
DDRPLL_VDD_1V0	G13	DDR PHY PLL power
PMU_VDD_1V0	R7	Internal PMU Domain Logic Power
PMUIO_VDD	T6	PMU Domain Digital IO Power
APIO1_VDD	N17	GPIO30 Digital IO Power
APIO2_VDD	K17	GPIO1830 Digital IO Power
LCDC_VDD	T4 T5	LCDC Digital IO Power
DVPIO_VDD	H7	DVP Digital IO Power
FLASH_VDD	V17	Nand Flash0 Digital IO Power
SDMMC_VDD	N21	SDMMC0 Digital IO Power
APIO3_VDD	H17	WIFI Digital IO Power
APIO4_VDD	G18	AUDIO Digital IO Power
AVSS	L3 N3 W3 AA5 H3 K3 T3 AB3	Analog Ground
APLL_AVDD_1V0	Y8	PLL Analog Power
APLL_AVSS	U8	PLL Analog Ground
C/DPLL_AVDD_1V0	W7	PLL Analog Power
C/DPLL_AVSS	V8	PLL Analog Ground
G/NPLL_AVDD_1V0	W8	PLL Analog Power
G/NPLL_AVSS	V7	PLL Analog Ground
ADC_AVDD_1V8	T7	SAR-ADC/TSADC Analog Power
USB_AVDD_1V0	V21	USB OTG2.0/Host2.0 Digital Power

Group	Ball #	Descriptions
USB_AVDD_1V8	V20	USB OTG2.0/Host2.0 Analog Power
USB_AVDD_3V3	P17	USB OTG2.0/Host2.0 Analog Power
USB_AVSS	AA20 AA22 AB21	USB Analog Ground
EFUSE_VQPS	Y10	eFuse IO Digital Power
USIC_VDD_1V2	Y21	USIC 1.2V Transmitter Power Supply
EDP_AVDD_1V0	L4	eDP 1.0V Power Supply
EDP_AVDD_1V8	L6	eDP 1.8V Power Supply
HDMI_AVDD_1V0	N7	HDMI 1.0V Power Supply
HDMI_AVDD_1V8	N6	HDMI 1.8V Power Supply
LVDS/MIPI_AVDD_1V0	K5	LVDS 1.0V Power Supply
LVDS/MIPI_AVDD_1V8	K4	LVDS 1.8V Power Supply
LVDS/MIPI_AVDD_3V3	K7	LVDS 3.3V Power Supply
MIPI_CSI_AVDD_1V0	J7	MIPI RX PHY 1.0V Power Supply

2.7 Function IO description

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
OSC_24M_IN	OSC_24M_IN	AC10	clk24m_xin				I	2mA	NA	I	PMU
OSC_24M_OUT	OSC_24M_OUT	AB10	clk24m_xout				O	2mA	NA	O	
NPOR	NPOR	AC8	npor				I	2mA	up	I	
TEST	TEST	P7	test				I	2mA	down	I	
DDR_RETEN_OUT	DDR_RETEN_OUT	AB12	ddr_reten				O	2mA	up	O	
CLK32_PWM2	CLK32K/PWM2	AA9	pwm_2	clk_32K			I/O	2mA	up	I	
GLOBALpwrroff_PMICsleep_PMUgpio0a0	GPIO0_A0/GLOBAL_PWROFF/PMIC_SLEEP	AC14	pmu_gpio0a0	global_pwrroff	pmic_sleep		I/O	2mA	down	I	
PMUgpio0a1	GPIO0_A1	AA12	pmu_gpio0a1				I/O	2mA	up	I	
PMUgpio0a2	GPIO0_A2	AB8	pmu_gpio0a2				I/O	2mA	up	I	
TSADCint_PMUdebug0_PMUgpio0a3	GPIO0_A3/OTP_OUT/PMU_DEBUG0	AB14	pmu_gpio0a3	tsadc_int	pmu_debug0		I/O	2mA	down	I	
PMUgpio0a4	GPIO0_A4	AA8	pmu_gpio0a4				I/O	2mA	down	I	
PMUgpio0a5	GPIO0_A5	AB13	pmu_gpio0a5				I/O	2mA	down	I	
I2C0PMUsda_PMUgpio0a6	GPIO0_A6/I2C0_SDA	AA13	pmu_gpio0a6	i2c0pmu_sda			I/O	2mA	up	I	
I2C0PMUscL_PMUgpio0a7	GPIO0_A7/I2C0_SCL	Y11	pmu_gpio0a7	i2c0pmu_scl			I/O	2mA	up	I	
TESTclkout_PWM1_PMUdebug1_PMUgpio0b0	GPIO0_B0/TEST_CLKOUT/PWM_1/PMU_DEBUG1	AC13	pmu_gpio0b0	test_clkout	pwm_1	pmu_debug1	I/O	2mA	down	I	
LCDCdata10_TRACEdata0_JTAGtrstn_LCDCgpio0b6	GPIO0_B6/LCDC_D10/TRACE_D0/JTAG_TRSTN	U4	lcdc_gpio0b6	lcdc_data10	trace_data0	jtag_trstn	I/O	8mA	down	I	LCDC
LCDCdata11_TRACEdata1_JTAGtdi_LCDCgpio0b7	GPIO0_B7/LCDC_D11/TRACE_D1/JTAG_TDI	V4	lcdc_gpio0b7	lcdc_data11	trace_data1	jtag_tdi	I/O	8mA	down	I	
LCDCdata12_TRACEdata2_JTAGtdo_LCDCgpio0c0	GPIO0_C0/LCDC_D12/TRACE_D2/JTAG_TDO	P5	lcdc_gpio0c0	lcdc_data12	trace_data2	jtag_tdo	I/O	8mA	down	I	
LCDCdata13_TRACEdata3_MCUJTAGtrstn_LCDCg	GPIO0_C1/LCDC_D13/TRACE_D3/MCUJTAG_TRSTN	P6	lcdc_gpio0c1	lcdc_data13	trace_data3	mcujtag_trstn	I/O	8mA	down	I	
LCDCdata14_TRACEdata4_MCUJTAGtdi_LCDCgpio0c2	GPIO0_C2/LCDC_D14/TRACE_D4/MCUJTAG_TDI	W4	lcdc_gpio0c2	lcdc_data14	trace_data4	mcujtag_tdi	I/O	8mA	down	I	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
LCDCdata15_TRACEdata5_MCUJTAGtdo_LCDCgpio0c3	GPI00_C3/LCDC_D15/TRACE_D5/MCUJTAG_TDO	P4	lcdc_gpio0c3	lcdc_data15	trace_data5	mcujtag_tdo	I/O	8mA	up	I	
LCDCdata16_TRACEdata6_UART1BBsin_LCDCgpio0c4	GPI00_C4/LCDC_D16/TRACE_D6/UART1_RX	U5	lcdc_gpio0c4	lcdc_data16	trace_data6	uart1bb_sin	I/O	8mA	down	I	
LCDCdata17_TRACEdata7_UART1BBsout_LCDCgpio0c5	GPI00_C5/LCDC_D17/TRACE_D7/UART1_TX	Y4	lcdc_gpio0c5	lcdc_data17	trace_data7	uart1bb_sout	I/O	8mA	down	I	
LCDCdata18_TRACEdata8_UART1BBctsn_LCDCgpio0c6	GPI00_C6/LCDC_D18/TRACE_D8/UART1_CTSN	V5	lcdc_gpio0c6	lcdc_data18	trace_data8	uart1bb_ctsn	I/O	8mA	down	I	
LCDCdata19_TRACEdata9_UART1BBrtsn_LCDCgpio0c7	GPI00_C7/LCDC_D19/TRACE_D9/UART1_RTSN	Y6	lcdc_gpio0c7	lcdc_data19	trace_data9	uart1bb_rtsn	I/O	8mA	down	I	
LCDCdata20_TRACEdata10_UART4EXPctsn_LCDCgpio0d0	GPI00_D0/LCDC_D20/TRACE_D10/UART4_CTSN	U6	lcdc_gpio0d0	lcdc_data20	trace_data10	uart4exp_ctsn	I/O	8mA	down	I	
LCDCdata21_TRACEdata11_UART4EXPrtsn_LCDCgpio0d1	GPI00_D1/LCDC_D21/TRACE_D11/UART4_RTSN	AA6	lcdc_gpio0d1	lcdc_data21	trace_data11	uart4exp_rtsn	I/O	8mA	down	I	
LCDCdata22_TRACEdata12_UART4EXPsout_LCDCgpio0d2	GPI00_D2/LCDC_D22/TRACE_D12/UART4_TX	Y5	lcdc_gpio0d2	lcdc_data22	trace_data12	uart4exp_sout	I/O	8mA	down	I	
LCDCdata23_TRACEdata13_UART4EXPsin_LCDCgpio0d3	GPI00_D3/LCDC_D23/TRACE_D13/UART4_RX	Y7	lcdc_gpio0d3	lcdc_data23	trace_data13	uart4exp_sin	I/O	8mA	down	I	
LCDCsync_TRACEdata14_PMUdebug2_LCDCgpio0d4	GPI00_D4/LCDC_HSYNC/TRACE_D14/PMU_DEBUG2	W6	lcdc_gpio0d4	lcdc_hsync	trace_data14	pmu_debug2	I/O	8mA	down	I	
LCDCvsync_TRACEdata15_PMUdebug3_LCDCgpio0d5	GPI00_D5/LCDC_VSYNC/TRACE_D15/PMU_DEBUG3	AC7	lcdc_gpio0d5	lcdc_vsync	trace_data15	pmu_debug3	I/O	8mA	down	I	
LCDCden_TRACEclk_PMUdebug4_LCDCgpio0d6	GPI00_D6/LCDC_DEN/TRACE_CLK/PMU_DEBUG4	AB7	lcdc_gpio0d6	lcdc_den	trace_clk	pmu_debug4	I/O	8mA	down	I	
LCDCclk_TRACEctl_PMUdebug5_LCDCgpio0d7	GPI00_D7/LCDC_DCLK/TRACE_CTL/PMU_DEBUG5	AA7	lcdc_gpio0d7	lcdc_clk	trace_ctl	pmu_debug5	I/O	12mA	down	I	
CIFdata2_TSdata0_DVPgpio1a0	GPI01_A0/CIF_D2/TS_D0	H4	dvp_gpio1a0	cif_data2	ts_data0		I/O	2mA	down	I	DVP

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
CIFdata3_TSdata1_DVPgpio1a1	GPIO1_A1/CIF_D3/TS_D1	H5	dvp_gpio1a1	cif_data3	ts_data1		I/O	2mA	down	I	
CIFdata4_TSdata2_DVPgpio1a2	GPIO1_A2/CIF_D4/TS_D2	G3	dvp_gpio1a2	cif_data4	ts_data2		I/O	2mA	down	I	
CIFdata5_TSdata3_DVPgpio1a3	GPIO1_A3/CIF_D5/TS_D3	G4	dvp_gpio1a3	cif_data5	ts_data3		I/O	2mA	down	I	
CIFdata6_TSdata4_DVPgpio1a4	GPIO1_A4/CIF_D6/TS_D4	E2	dvp_gpio1a4	cif_data6	ts_data4		I/O	2mA	down	I	
CIFdata7_TSdata5_DVPgpio1a5	GPIO1_A5/CIF_D7/TS_D5	F3	dvp_gpio1a5	cif_data7	ts_data5		I/O	2mA	down	I	
CIFdata8_TSdata6_DVPgpio1a6	GPIO1_A6/CIF_D8/TS_D6	D1	dvp_gpio1a6	cif_data8	ts_data6		I/O	2mA	down	I	
CIFdata9_TSdata7_DVPgpio1a7	GPIO1_A7/CIF_D9/TS_D7	D2	dvp_gpio1a7	cif_data9	ts_data7		I/O	2mA	down	I	
CIFvsync_TSsync_DVPgpio1b0	GPIO1_B0/CIF_VSYNC/TS_SYNC	E1	dvp_gpio1b0	cif_vsync	ts_sync		I/O	2mA	down	I	
CIFhref_TSvalid_DVPgpio1b1	GPIO1_B1/CIF_HREF/TS_VALID	F4	dvp_gpio1b1	cif_href	ts_valid		I/O	2mA	down	I	
CIFclkkin_TSclk_DVPgpio1b2	GPIO1_B2/CIF_CLKIN/TS_CLK	G6	dvp_gpio1b2	cif_clkkin	ts_clk		I/O	2mA	down	I	
CIFclkout_TSfail_DVPgpio1b3	GPIO1_B3/CIF_CLKOUT/TS_FAIL	G5	dvp_gpio1b3	cif_clkout	ts_fail		I/O	8mA	down	I	
CIFdata0_DVPgpio1b4	GPIO1_B4/CIF_D0	E3	dvp_gpio1b4	cif_data0			I/O	2mA	down	I	
CIFdata1_DVPgpio1b5	GPIO1_B5/CIF_D1	D3	dvp_gpio1b5	cif_data1			I/O	2mA	down	I	
CIFdata10_SPI1clk_DVPgpio1b6	GPIO1_B6/CIF_D10/SPI1_CLK	B1	dvp_gpio1b6	cif_data10	spi1_clk		I/O	2mA	down	I	
CIFdata11_SPI1csn0_DVPgpio1b7	GPIO1_B7/CIF_D11/SPI1_CSN0	F5	dvp_gpio1b7	cif_data11	spi1_csn0		I/O	2mA	down	I	
I2C3CAMscl_SPI1rxn_DVPgpio1c0	GPIO1_C0/I2C3_SCL/SPI1_RXD	A1	dvp_gpio1c0	i2c3cam_scl	spi1_rxd		I/O	2mA	up	I	
I2C3CAMsda_SPI1txd_DVPgpio1c1	GPIO1_C1/I2C3_SDA/SPI1_TXD	E4	dvp_gpio1c1	i2c3cam_sda	spi1_txd		I/O	2mA	up	I	
FLASHdata0_EMMCdata0_SFCsio_FLASHgpio1c2	GPIO1_C2/FLASH_D0/EMMC_D0/SFC_SIO0	AB18	flash_gpio1c2	flash_data0	emmc_data0	sfc_sio0	I/O	8mA	up	I	FLASH
FLASHdata1_EMMCdata1_SFCsio_FLASHgpio1c3	GPIO1_C3/FLASH_D1/EMMC_D1/SFC_SIO1	AA17	flash_gpio1c3	flash_data1	emmc_data1	sfc_sio1	I/O	8mA	up	I	
FLASHdata2_EMMCdata2_SFCsio_FLASHgpio1c4	GPIO1_C4/FLASH_D2/EMMC_D2/SFC_SIO2	AA18	flash_gpio1c4	flash_data2	emmc_data2	sfc_sio2	I/O	8mA	up	I	
FLASHdata3_EMMCdata3_SFCsio_FLASHgpio1c5	GPIO1_C5/FLASH_D3/EMMC_D3/SFC_SIO3	W18	flash_gpio1c5	flash_data3	emmc_data3	sfc_sio3	I/O	8mA	up	I	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
FLASHdata4_EMMCdata4_SPI0rxn_FLASHgpio1c6	GPIO1_C6/FLASH_D4/EMMC_D4/SPI0_RXD	Y18	flash_gpio1c6	flash_data4	emmc_data4	spi0_rxd	I/O	8mA	up	I	
FLASHdata5_EMMCdata5_SPI0txd_FLASHgpio1c7	GPIO1_C7/FLASH_D5/EMMC_D5/SPI0_TXD	AC19	flash_gpio1c7	flash_data5	emmc_data5	spi0_txd	I/O	8mA	up	I	
FLASHdata6_EMMCdata6_SPI0csn0_FLASHgpio1d0	GPIO1_D0/FLASH_D6/EMMC_D6/SPI0_CS0	Y19	flash_gpio1d0	flash_data6	emmc_data6	spi0_csn0	I/O	8mA	up	I	
FLASHdata7_EMMCdata7_SPI0csn1_FLASHgpio1d1	GPIO1_D1/FLASH_D7/EMMC_D7/SPI0_CS1	AA19	flash_gpio1d1	flash_data7	emmc_data7	spi0_csn1	I/O	8mA	up	I	
FLASHrdy_EMMCcmd_SFCclk_FLASHgpio1d2	GPIO1_D2/FLASH_RDY/EMMC_CMD/SFC_CLK	AC16	flash_gpio1d2	flash_rdy	emmc_cmd	sfc_clk	I/O	4mA	up	I	
FLASHwp_EMMCpwren_FLASHgpio1d3	GPIO1_D3/FLASH_WP/EMMC_PWREN	AB16	flash_gpio1d3	flash_wp	emmc_pwren		I/O	4mA	down	I	
FLASHrdn_SFCcsn1_FLASHgpio1d4	GPIO1_D4/FLASH_RDN/SFC_CS1	AB17	flash_gpio1d4	flash_rdn	sfc_csn1		I/O	4mA	up	I	
FLASHale_SPI0clk_FLASHgpio1d5	GPIO1_D5/FLASH_ALE/SPI0_CLK	W17	flash_gpio1d5	flash_ale	spi0_clk		I/O	4mA	down	I	
FLASHcle_FLASHgpio1d6	GPIO1_D6/FLASH_CLE	AC17	flash_gpio1d6	flash_cle			I/O	4mA	down	I	
FLASHwrn_SFCcsn0_FLASHgpio1d7	GPIO1_D7/FLASH_WRN/SFC_CS0	Y17	flash_gpio1d7	flash_wrn	sfc_csn0		I/O	8mA	up	I	
FLASHcsn0_FLASHgpio2a0	GPIO2_A0/FLASH_CS0	AA16	flash_gpio2a0	flash_csn0			I/O	4mA	up	I	
FLASHcsn1_FLASHgpio2a1	GPIO2_A1/FLASH_CS1	AA14	flash_gpio2a1	flash_csn1			I/O	4mA	up	I	
FLASHcsn2_FLASHgpio2a2	GPIO2_A2/FLASH_CS2	AB15	flash_gpio2a2	flash_csn2			I/O	4mA	up	I	
FLASHcsn3_EMMCcrstnout_FLASHgpio2a3	GPIO2_A3/FLASH_CS3/EMMC_RSTNOUT	Y16	flash_gpio2a3	flash_csn3	emmc_rstnout		I/O	4mA	up	I	
FLASHdqs_EMMCclkout_FLASHgpio2a4	GPIO2_A4/FLASH_DQS/EMMC_CLKOUT	AA15	flash_gpio2a4	flash_dqs	emmc_clkout		I/O	8mA	up	I	
SDMMC0data0_UART2DBGsout_SDCARDgpio2a5	GPIO2_A5/SDMMC0_D0/UART2_TX	P18	sdcard_gpio2a5	sdmmc0_data0	uart2dbg_sout		I/O	4mA	up	I	SDMMC
SDMMC0data1_UART2DBGsin_SDCARDgpio2a6	GPIO2_A6/SDMMC0_D1/UART2_RX	P22	sdcard_gpio2a6	sdmmc0_data1	uart2dbg_sin		I/O	4mA	up	I	
SDMMC0data2_JTAGtck_SDCARDgpio2a7	GPIO2_A7/SDMMC0_D2/JTAG_TCK	R22	sdcard_gpio2a7	sdmmc0_data2	jtag_tck		I/O	4mA	up	I	
SDMMC0data3_JTAGtms_SDCARDgpio2b0	GPIO2_B0/SDMMC0_D3/JTAG_TMS	P23	sdcard_gpio2b0	sdmmc0_data3	jtag_tms		I/O	4mA	up	I	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
SDMMC0clkout_MCUJTAGtck_SDCARDgpio2b1	GPIO2_B1/SDMMC0_CLKOUT/MCUJTAG_TCK	N22	sdcard_gpio2b1	sdmmc0_clkout	mcujtag_tck		I/O	8mA	down	I	
SDMMC0cmd_MCUJTAGtms_SDCARDgpio2b2	GPIO2_B2/SDMMC0_CMD/MCUJTAG_TMS	N19	sdcard_gpio2b2	sdmmc0_cmd	mcujtag_tms		I/O	4mA	up	I	
SDMMC0dectn_SDCARDgpio2b3	GPIO2_B3/SDMMC0_DECTN	M21	sdcard_gpio2b3	sdmmc0_dectn			I/O	2mA	up	I	
I2Ssclk_AUDIOgpio2b4	GPIO2_B4/I2S_SCLK	K18	audio_gpio2b4	i2s_sclk			I/O	4mA	down	I	AUDIO
I2Slrckrx_PCMSync_AUDIOgpio2b5	GPIO2_B5/I2S_LRCK_RX/PCM_SYNC	K23	audio_gpio2b5	i2s_lrckrx	pcm_sync		I/O	2mA	down	I	(APIO3)
I2Slrctx_AUDIOgpio2b6	GPIO2_B6/I2S_LRCK_TX	J21	audio_gpio2b6	i2s_lrctx			I/O	2mA	down	I	
I2Ssdi_AUDIOgpio2b7	GPIO2_B7/I2S_SDI	H20	audio_gpio2b7	i2s_sdi			I/O	2mA	down	I	
I2Ssdo0_AUDIOgpio2c0	GPIO2_C0/I2S_SDO0	H22	audio_gpio2c0	i2s_sdo0			I/O	2mA	down	I	
I2Ssdo1_PCMout_AUDIOgpio2c1	GPIO2_C1/I2S_SDO1/PCM_OUT	F19	audio_gpio2c1	i2s_sdo1	pcm_out		I/O	2mA	down	I	
I2Ssdo2_PCMclk_AUDIOgpio2c2	GPIO2_C2/I2S_SDO2/PCM_CLK	J22	audio_gpio2c2	i2s_sdo2	pcm_clk		I/O	2mA	down	I	
I2Ssdo3_PCMin_AUDIOgpio2c3	GPIO2_C3/I2S_SDO3/PCM_IN	H21	audio_gpio2c3	i2s_sdo3	pcm_in		I/O	2mA	down	I	
I2Sclk_AUDIOgpio2c4	GPIO2_C4/I2S_CLK	H23	audio_gpio2c4	i2s_clk			I/O	2mA	down	I	
I2C1AUDIOSda_AUDIOgpio2c5	GPIO2_C5/I2C1_SDA	G19	audio_gpio2c5	i2c1audio_sda			I/O	2mA	up	I	
I2C1AUDIOScl_AUDIOgpio2c6	GPIO2_C6/I2C1_SCL	G20	audio_gpio2c6	i2c1audio_scl			I/O	2mA	up	I	
SPDIFtx_EDPhpd_AUDIOgpio2c7	GPIO2_C7/SPDIF_TX/EDP_HPDP	G23	audio_gpio2c7	spdif_tx	edp_hpdp		I/O	2mA	down	I	
UART0BTsin_WIFIgpio2d0	GPIO2_D0/UART0_RX	K22	wifi_gpio2d0	uart0bt_sin			I/O	2mA	up	I	WIFI_B T
UART0BTsout_WIFIgpio2d1	GPIO2_D1/UART0_TX	K19	wifi_gpio2d1	uart0bt_sout			I/O	2mA	down	I	(APIO2)
UART0BTctsn_WIFIgpio2d2	GPIO2_D2/UART0_CTSN	K21	wifi_gpio2d2	uart0bt_ctsn			I/O	2mA	up	I	
UART0BTrtsn_WIFIgpio2d3	GPIO2_D3/UART0_RTSEN	H18	wifi_gpio2d3	uart0bt_rtsn			I/O	2mA	up	I	
SDIO0data0_WIFIgpio2d4	GPIO2_D4/SDIO0_D0	M22	wifi_gpio2d4	sdio0_data0			I/O	4mA	up	I	
SDIO0data1_WIFIgpio2d5	GPIO2_D5/SDIO0_D1	N20	wifi_gpio2d5	sdio0_data1			I/O	4mA	up	I	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
SDIO0data2_WIFIgnpio2d6	GPIO2_D6/SDIO0_D2	N23	wifi_gpio2d6	sdio0_data2			I/O	4mA	up	I	
SDIO0data3_WIFIgnpio2d7	GPIO2_D7/SDIO0_D3	L20	wifi_gpio2d7	sdio0_data3			I/O	4mA	up	I	
SDIO0cmd_WIFIgnpio3a0	GPIO3_A0/SDIO0_CMD	L21	wifi_gpio3a0	sdio0_cmd			I/O	4mA	up	I	
SDIO0clkout_WIFIgnpio3a1	GPIO3_A1/SDIO0_CLKOUT	L19	wifi_gpio3a1	sdio0_clkout			I/O	8mA	down	I	
SDIO0detectn_WIFIgnpio3a2	GPIO3_A2/SDIO0_DETECTN	L18	wifi_gpio3a2	sdio0_detectn			I/O	2mA	up	I	
SDIO0wrprt_WIFIgnpio3a3	GPIO3_A3/SDIO0_WRPRT	L22	wifi_gpio3a3	sdio0_wrprt			I/O	2mA	down	I	
SDIO0pwren_WIFIgnpio3a4	GPIO3_A4/SDIO0_PWREN	L17	wifi_gpio3a4	sdio0_pwren			I/O	2mA	down	I	
SDIO0bkpwr_WIFIgnpio3a5	GPIO3_A5/SDIO0_BKPWR	L23	wifi_gpio3a5	sdio0_bkpwr			I/O	2mA	down	I	
SDIO0intn_WIFIgnpio3a6	GPIO3_A6/SDIO0_INTN	K20	wifi_gpio3a6	sdio0_intn			I/O	2mA	up	I	
WIFIgnpio3a7	GPIO3_A7	H19	wifi_gpio3a7				I/O	2mA	up	I	
MACTxd0_PWM0_VOPpwm_GPIO30gpio3b0	GPIO3_B0/MAC_TXD0/PWM0/VOP_PWM	T18	gpio30_gpio3b0	mac_txd0	pwm_0	vop_pwm	I/O	8mA	down	I	GPIO30
MACTxd1_GPIO30gpio3b1	GPIO3_B1/MAC_TXD1	U19	gpio30_gpio3b1	mac_txd1			I/O	8mA	down	I	(APIO1)
MACTxd2_GPIO30gpio3b2	GPIO3_B2/MAC_TXD2	T20	gpio30_gpio3b2	mac_txd2			I/O	8mA	down	I	
MACcrs_GPIO30gpio3b3	GPIO3_B3/MAC_CRCS	V22	gpio30_gpio3b3	mac_crs			I/O	2mA	down	I	
MACcol_GPIO30gpio3b4	GPIO3_B4/MAC_COL	W23	gpio30_gpio3b4	mac_col			I/O	2mA	up	I	
MACTxen_GPIO30gpio3b5	GPIO3_B5/MAC_TXEN	V19	gpio30_gpio3b5	mac_txen			I/O	8mA	down	I	
MACTxd3_GPSmag_GPIO30gpio3b6	GPIO3_B6/MAC_TXD3/GPS_MAG	T19	gpio30_gpio3b6	mac_txd3	gps_mag		I/O	8mA	up	I	
MACrxd0_GPSsig_GPIO30gpio3b7	GPIO3_B7/MAC_RXD0/GPS_SIG	AB19	gpio30_gpio3b7	mac_rxd0	gps_sig		I/O	4mA	down	I	
MACrxd1_UART3GPSctsn_GPSrfclk_GPIO30gpio3c0	GPIO3_C0/MAC_RXD1/UART3_CTSN/GPS_RFCLK	U21	gpio30_gpio3c0	mac_rxd1	uart3gps_ctsn	gps_rfclk	I/O	4mA	up	I	
MACrxd2_UART3GPSrtsn_USBdrvvbus0_GPIO30gpio3c1	GPIO3_C1/MAC_RXD2/UART3_RTSN/USB_DRVVBUS0	T21	gpio30_gpio3c1	mac_rxd2	uart3gps_rtsn	usb_drvvbus0	I/O	4mA	up	I	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
MACrx3_USBdrvbus1_GPIO30gpio3c2	GPIO3_C2/MAC_RXD3/USB_DRVVBUS1	Y23	gpio30_gpio3c2	mac_rxd3	usb_drvvbus1		I/O	4mA	down	I	
MACmdc_ISPshutteren_GPIO30gpio3c3	GPIO3_C3/MAC_MDC/ISP_SHUTTEREN	U22	gpio30_gpio3c3	mac_mdc	isp_shutteren		I/O	2mA	down	I	
MACrxdv_ISPflashtrigout_GPIO30gpio3c4	GPIO3_C4/MAC_RXDV/ISP_FLASHTRIGOUT	W22	gpio30_gpio3c4	mac_rxdv	isp_flashtrigout		I/O	4mA	up	I	
MACrxer_ISPprelighttrig_GPIO30gpio3c5	GPIO3_C5/MAC_RXER/ISP_PRELIGHTTRIG	P21	gpio30_gpio3c5	mac_rxer	isp_prelighttrig		I/O	2mA	down	I	
MACclk_ISPshuttertrig_GPIO30gpio3c6	GPIO3_C6/MAC_CLK/ISP_SHUTTERTRIG	W21	gpio30_gpio3c6	mac_clk	isp_shuttertrig		I/O	12mA	down	I	
EDPHDMIcecinout_ISPflashtrigin_GPIO30gpio3c7	GPIO3_C7/EDPHDMI_CEC/ISP_FLASHTRIGIN	U23	gpio30_gpio3c7	edphdmi_cecinout	isp_flashtrigin		I/O	2mA	up	I	
MACmdI2C4TPsda_GPIO30gpio3d0	GPIO3_D0/MAC_MDIO/I2C4_SDA	N18	gpio30_gpio3d0	mac_mdio	i2c4tp_sda		I/O	2mA	up	I	
MACrxclk_in_I2C4TPscl_GPIO30gpio3d1	GPIO3_D1/MAC_RXCLKIN/I2C4_SCL	U18	gpio30_gpio3d1	mac_rxclk_in	i2c4tp_scl		I/O	4mA	up	I	
HDMII2Csda_I2C5HDMI_sda_GPIO30gpio3d2	GPIO3_D2/HDMI_I2C_SDA/I2C5_SDA	T22	gpio30_gpio3d2	hdmi_i2c_sda	i2c5hdmi_sda		I/O	2mA	up	I	
HDMII2Cscl_I2C5HDMI_scl_GPIO30gpio3d3	GPIO3_D3/HDMI_I2C_SCL/I2C5_SCL	T23	gpio30_gpio3d3	hdmi_i2c_scl	i2c5hdmi_scl		I/O	2mA	up	I	
MACTxclkout_SPI1csn1_GPIO30gpio3d4	GPIO3_D4/MAC_TX_CLKO/SPI1_CSN1	W20	gpio30_gpio3d4	mac_txclkout	spi1_csn1		I/O	12mA	down	I	
IRrx_UART3GPSsin_GPIO30gpio3d5	GPIO3_D5/IR_RX/UART3_RX	P19	gpio30_gpio3d5	ir_rx	uart3gps_sin		I/O	2mA	up	I	
IRtx_UART3GPSsout_PWM3_GPIO30gpio3d6	GPIO3_D6/IR_TX/UART3_TX/PWM3/IR_REMOTE_IN	R21	gpio30_gpio3d6	ir_tx	uart3gps_sout	pwm_3	I/O	2mA	up	I	
SCvcc18v_I2C2SENSORsda_GPUJTAGtck_GPIO1830gpio3d7	GPIO3_D7/SC_VCC18V/I2C2_SDA/GPUJTAG_TCK	E20	gpio1830_gpio3d7	sc_vcc18v	i2c2sensor_sda	gpujtag_tck	I/O	2mA	up	I	GPIO1830
SCvcc33v_I2C2SENSORscl_GPUJTAGtrstn_GPIO1830gpio0b1	GPIO0_B1/SC_VCC33V/I2C2_SCL/GPUJTAG_TRSTN	F20	gpio1830_gpio0b1	sc_vcc33v	i2c2sensor_scl	gpujtag_trstn	I/O	2mA	up	I	(APIO4)
SCrst_SPI2rxn_GPIOJTAGtms_GPIO1830gpio0b2	GPIO0_B2/SC_RST/SPI2_RXD/GPUJTAG_TMS	F21	gpio1830_gpio0b2	sc_rst	spi2_rxd	gpujtag_tms	I/O	2mA	up	I	
SCclk_SPI2txd_GPIOJTAGtdi_GPIO1830gpio0b3	GPIO0_B3/SC_CLK/SPI2_TXD/GPUJTAG_TDI	G21	gpio1830_gpio0b3	sc_clk	spi2_txd	gpujtag_tdi	I/O	2mA	up	I	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
SCSPI2clk_GPUJTAGtdo_GPIO1830gpio0b4	GPIO0_B4/SC_IO/SPI2_CLK/GPUJTAG_TDO	G22	gpio1830_gpio0b4	sc_io	spi2_clk	gpujtag_tdo	I/O	2mA	up	I	
SCdetect_SPI2csn0_GPIO1830gpio0b5	GPIO0_B5/SC_DETECT/SPI2_CSN0/FLASH_VOL_SEL	F22	gpio1830_gpio0b5	sc_detect	spi2_csn0		I/O	2mA	up	I	
ADC_IN0	ADC_IN0	AA11	saradc_ain0				A	NA	NA	NA	SARADC
ADC_IN1	ADC_IN1	AC11	saradc_ain1				A	NA	NA	NA	
ADC_IN2	ADC_IN2	AB11	saradc_ain2				A	NA	NA	NA	
EDP_AUXN	EDP_AUXN	AA3	edp_auxn				A	NA	NA	NA	EDP
EDP_AUXP	EDP_AUXP	AA2	edp_auxp				A	NA	NA	NA	
EDP_DC_TP	EDP_DC_TP	M7	edp_dctp				A	NA	NA	NA	
EDP_CLKI_24M	EDP_CLKI_24M	L7	edp_osclk24m				A	NA	NA	NA	
EDP_RBIAS	EDP_RBIAS	L5	edp_rbias				A	NA	NA	NA	
EDP_TX0N	EDP_TX0N	U2	edp_tx0n				A	NA	NA	NA	
EDP_TX0P	EDP_TX0P	U1	edp_tx0p				A	NA	NA	NA	
EDP_TX1N	EDP_TX1N	V3	edp_tx1n				A	NA	NA	NA	
EDP_TX1P	EDP_TX1P	V2	edp_tx1p				A	NA	NA	NA	
EDP_TX2N	EDP_TX2N	W2	edp_tx2n				A	NA	NA	NA	
EDP_TX2P	EDP_TX2P	W1	edp_tx2p				A	NA	NA	NA	
EDP_TX3N	EDP_TX3N	Y2	edp_tx3n				A	NA	NA	NA	
EDP_TX3P	EDP_TX3P	Y1	edp_tx3p				A	NA	NA	NA	
HDMI_HPD	HDMI_HPD	N4	hdmiphy_hpd				A	NA	NA	NA	HDMI
HDMI_RBIAS	HDMI_RBIAS	N5	hdmiphy_rext				A	NA	NA	NA	
HDMI_TCN	HDMI_TCN	AC1	hdmiphy_tmdsc_lkn				A	NA	NA	NA	
HDMI_TCP	HDMI_TCP	AB1	hdmiphy_tmdsc_lkp				A	NA	NA	NA	
HDMI_TX0N	HDMI_TX0N	AC2	hdmiphy_tmdsd_atan0				A	NA	NA	NA	
HDMI_TX1N	HDMI_TX1N	AC4	hdmiphy_tmdsd_atan1				A	NA	NA	NA	
HDMI_TX2N	HDMI_TX2N	AC5	hdmiphy_tmdsd_atan2				A	NA	NA	NA	
HDMI_TX0P	HDMI_TX0P	AB2	hdmiphy_tmdsd_atap0				A	NA	NA	NA	
HDMI_TX1P	HDMI_TX1P	AB4	hdmiphy_tmdsd_atap1				A	NA	NA	NA	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
HDMI_TX2P	HDMI_TX2P	AB5	hdmiphy_tmtdsd atap2				A	NA	NA	NA	
USIC_DATA	USIC_DATA	AB20	USIC_data				A	NA	NA	NA	USIC
USIC_STROBE	USIC_STROBE	AC20	USIC_strobe				A	NA	NA	NA	
MIPI_CSI_CLKN	MIPI_CSI_CLKN	J3	mipicsi_clkn				A	NA	NA	NA	MIPICSI
MIPI_CSI_CLKP	MIPI_CSI_CLKP	J2	mipicsi_clkp				A	NA	NA	NA	
MIPI_CSI_DN0	MIPI_CSI_DN0	G2	mipicsi_datan0				A	NA	NA	NA	
MIPI_CSI_DN1	MIPI_CSI_DN1	H2	mipicsi_datan1				A	NA	NA	NA	
MIPI_CSI_DN2	MIPI_CSI_DN2	K2	mipicsi_datan2				A	NA	NA	NA	
MIPI_CSI_DN3	MIPI_CSI_DN3	L2	mipicsi_datan3				A	NA	NA	NA	
MIPI_CSI_DP0	MIPI_CSI_DP0	G1	mipicsi_datap0				A	NA	NA	NA	
MIPI_CSI_DP1	MIPI_CSI_DP1	H1	mipicsi_datap1				A	NA	NA	NA	
MIPI_CSI_DP2	MIPI_CSI_DP2	K1	mipicsi_datap2				A	NA	NA	NA	
MIPI_CSI_DP3	MIPI_CSI_DP3	L1	mipicsi_datap3				A	NA	NA	NA	
MIPI_CSI_RBIAS	MIPI_CSI_RBIAS	H6	mipicsi_extrbias				A	NA	NA	NA	
IO_LCDCdata5_LVDSclk_MIPIDSIclkn	MIPI_DSI_CLKN/LCDC_D5/LVDS_CLKN	P1	mipidsi_clkn	lcdc_data5	lvds_clkn		A	NA	NA	NA	
IO_LCDCdata4_LVDSclk_MIPIDSIclkp	MIPI_DSI_CLKP/LCDC_D4/LVDS_CLKP	P2	mipidsi_clkp	lcdc_data4	lvds_clkp		A	NA	NA	NA	
IO_LCDCdata9_LVDSdatan0_MIPIDSIdatan0	MIPI_DSI_DN0/LCDC_D9/LVDS_DN0	M2	mipidsi_datan0	lcdc_data9	lvds_datan0		A	NA	NA	NA	
IO_LCDCdata7_LVDSdatan1_MIPIDSIdatan1	MIPI_DSI_DN1/LCDC_D7/LVDS_DN1	N1	mipidsi_datan1	lcdc_data7	lvds_datan1		A	NA	NA	NA	
IO_LCDCdata2_LVDSdatan2_MIPIDSIdatan2	MIPI_DSI_DN2/LCDC_D2/LVDS_DN2	R2	mipidsi_datan2	lcdc_data2	lvds_datan2		A	NA	NA	NA	
IO_LCDCdata0_LVDSdatan3_MIPIDSIdatan3	MIPI_DSI_DN3/LCDC_D0/LVDS_DN3	T1	mipidsi_datan3	lcdc_data0	lvds_datan3		A	NA	NA	NA	
IO_LCDCdata8_LVDSdatap0_MIPIDSIdatap0	MIPI_DSI_DP0/LCDC_D8/LVDS_DP0	M3	mipidsi_datap0	lcdc_data8	lvds_datap0		A	NA	NA	NA	
IO_LCDCdata6_LVDSdatap1_MIPIDSIdatap1	MIPI_DSI_DP1/LCDC_D6/LVDS_DP1	N2	mipidsi_datap1	lcdc_data6	lvds_datap1		A	NA	NA	NA	
IO_LCDCdata3_LVDSdatap2_MIPIDSIdatap2	MIPI_DSI_DP2/LCDC_D3/LVDS_DP2	R3	mipidsi_datap2	lcdc_data3	lvds_datap2		A	NA	NA	NA	
IO_LCDCdata1_LVDSdatap3_MIPIDSIdatap3	MIPI_DSI_DP3/LCDC_D1/LVDS_DP3	T2	mipidsi_datap3	lcdc_data1	lvds_datap3		A	NA	NA	NA	
MIPI_DSI_RBIAS	MIPI_DSI_RBIAS	K6	mipidsi_rbias				A	NA	NA	NA	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
USB0_ID	USB0_ID	Y20	usbphy_usb0id				A	NA	NA	NA	USB
USB0_DM	USB0_DM	AC22	usbphy_usb0pn				A	NA	NA	NA	
USB0_DP	USB0_DP	AB22	usbphy_usb0pp				A	NA	NA	NA	
USB1_DM	USB1_DM	AC23	usbphy_usb1pn				A	NA	NA	NA	
USB1_DP	USB1_DP	AB23	usbphy_usb1pp				A	NA	NA	NA	
USB_RBIAS	USB_RBIAS	R17	usbphy_usbrbias				A	NA	NA	NA	
USB_VBUS	USB_VBUS	AA21	usbphy_vbus				A	NA	NA	NA	DDR
DDR_DM0	DDR_DM0	D20	ddrphya_dm0				A	NA	NA	NA	
DDR_DM1	DDR_DM1	E6	ddrphya_dm1				A	NA	NA	NA	
DDR_DQ0	DDR_DQ0	E22	ddrphya_dq0				A	NA	NA	NA	
DDR_DQ1	DDR_DQ1	D21	ddrphya_dq1				A	NA	NA	NA	
DDR_DQ10	DDR_DQ10	B6	ddrphya_dq10				A	NA	NA	NA	
DDR_DQ11	DDR_DQ11	E7	ddrphya_dq11				A	NA	NA	NA	
DDR_DQ12	DDR_DQ12	C7	ddrphya_dq12				A	NA	NA	NA	
DDR_DQ13	DDR_DQ13	E8	ddrphya_dq13				A	NA	NA	NA	
DDR_DQ14	DDR_DQ14	D8	ddrphya_dq14				A	NA	NA	NA	
DDR_DQ15	DDR_DQ15	C8	ddrphya_dq15				A	NA	NA	NA	
DDR_DQ2	DDR_DQ2	C22	ddrphya_dq2				A	NA	NA	NA	
DDR_DQ3	DDR_DQ3	D22	ddrphya_dq3				A	NA	NA	NA	
DDR_DQ4	DDR_DQ4	A23	ddrphya_dq4				A	NA	NA	NA	
DDR_DQ5	DDR_DQ5	B23	ddrphya_dq5				A	NA	NA	NA	
DDR_DQ6	DDR_DQ6	D23	ddrphya_dq6				A	NA	NA	NA	
DDR_DQ7	DDR_DQ7	E23	ddrphya_dq7				A	NA	NA	NA	
DDR_DQ8	DDR_DQ8	D6	ddrphya_dq8				A	NA	NA	NA	
DDR_DQ9	DDR_DQ9	C6	ddrphya_dq9				A	NA	NA	NA	
DDR_DQS0	DDR_DQS0	B22	ddrphya_dqs0				A	NA	NA	NA	
DDR_DQS1	DDR_DQS1	B7	ddrphya_dqs1				A	NA	NA	NA	
DDR_DQS0N	DDR_DQS0N	A22	ddrphya_dqs0				A	NA	NA	NA	
DDR_DQS1N	DDR_DQS1N	A7	ddrphya_dqs1				A	NA	NA	NA	
DDR_A0	DDR_A0	A11	ddrphy_a0				A	NA	NA	NA	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
DDR_A1	DDR_A1	C12	ddrphy_a1				A	NA	NA	NA	
DDR_A10	DDR_A10	C15	ddrphy_a10				A	NA	NA	NA	
DDR_A11	DDR_A11	B15	ddrphy_a11				A	NA	NA	NA	
DDR_A12	DDR_A12	D18	ddrphy_a12				A	NA	NA	NA	
DDR_A13	DDR_A13	C16	ddrphy_a13				A	NA	NA	NA	
DDR_A14	DDR_A14	B16	ddrphy_a14				A	NA	NA	NA	
DDR_A15	DDR_A15	A16	ddrphy_a15				A	NA	NA	NA	
DDR_A2	DDR_A2	B12	ddrphy_a2				A	NA	NA	NA	
DDR_A3	DDR_A3	E13	ddrphy_a3				A	NA	NA	NA	
DDR_A4	DDR_A4	C13	ddrphy_a4				A	NA	NA	NA	
DDR_A5	DDR_A5	A14	ddrphy_a5				A	NA	NA	NA	
DDR_A6	DDR_A6	B14	ddrphy_a6				A	NA	NA	NA	
DDR_A7	DDR_A7	C14	ddrphy_a7				A	NA	NA	NA	
DDR_A8	DDR_A8	D14	ddrphy_a8				A	NA	NA	NA	
DDR_A9	DDR_A9	E14	ddrphy_a9				A	NA	NA	NA	
DDR_DM2	DDR_DM2	C20	ddrphyb_dm0				A	NA	NA	NA	
DDR_DM3	DDR_DM3	A2	ddrphyb_dm1				A	NA	NA	NA	
DDR_DQ16	DDR_DQ16	C18	ddrphyb_dq0				A	NA	NA	NA	
DDR_DQ17	DDR_DQ17	B17	ddrphyb_dq1				A	NA	NA	NA	
DDR_DQ26	DDR_DQ26	C3	ddrphyb_dq10				A	NA	NA	NA	
DDR_DQ27	DDR_DQ27	C4	ddrphyb_dq11				A	NA	NA	NA	
DDR_DQ28	DDR_DQ28	D5	ddrphyb_dq12				A	NA	NA	NA	
DDR_DQ29	DDR_DQ29	C5	ddrphyb_dq13				A	NA	NA	NA	
DDR_DQ30	DDR_DQ30	B5	ddrphyb_dq14				A	NA	NA	NA	
DDR_DQ31	DDR_DQ31	A5	ddrphyb_dq15				A	NA	NA	NA	
DDR_DQ18	DDR_DQ18	A17	ddrphyb_dq2				A	NA	NA	NA	
DDR_DQ19	DDR_DQ19	A20	ddrphyb_dq3				A	NA	NA	NA	
DDR_DQ20	DDR_DQ20	C19	ddrphyb_dq4				A	NA	NA	NA	
DDR_DQ21	DDR_DQ21	B18	ddrphyb_dq5				A	NA	NA	NA	
DDR_DQ22	DDR_DQ22	B20	ddrphyb_dq6				A	NA	NA	NA	

Pad#	PIN NAME	Ball#	Func0	Func1	Func2	Func3	Pad type ^①	Current ^②	Pull ^③	Reset State ^④	Power Supply ^⑤
DDR_DQ23	DDR_DQ23	B21	ddrphyb_dq7				A	NA	NA	NA	
DDR_DQ24	DDR_DQ24	B2	ddrphyb_dq8				A	NA	NA	NA	
DDR_DQ25	DDR_DQ25	B3	ddrphyb_dq9				A	NA	NA	NA	
DDR_DQS2	DDR_DQS2	B19	ddrphyb_dqs0				A	NA	NA	NA	
DDR_DQS3	DDR_DQS3	B4	ddrphyb_dqs1				A	NA	NA	NA	
DDR_DQS2N	DDR_DQS2N	A19	ddrphyb_dqsb0				A	NA	NA	NA	
DDR_DQS3N	DDR_DQS3N	A4	ddrphyb_dqsb1				A	NA	NA	NA	
DDR_BA0	DDR_BA0	D11	ddrphy_b0				A	NA	NA	NA	
DDR_BA1	DDR_BA1	C11	ddrphy_b1				A	NA	NA	NA	
DDR_BA2	DDR_BA2	B11	ddrphy_b2				A	NA	NA	NA	
DDR_CASN	DDR_CASN	B10	ddrphy_casb				A	NA	NA	NA	
DDR_CLK	DDR_CLK	B13	ddrphy_ck				A	NA	NA	NA	
DDR_CLKN	DDR_CLKN	A13	ddrphy_ckb				A	NA	NA	NA	
DDR_CKE0	DDR_CKE0	C9	ddrphy_cke0				A	NA	NA	NA	
DDR_CKE1	DDR_CKE1	B8	ddrphy_cke1				A	NA	NA	NA	
DDR_CS0N	DDR_CS0N	A8	ddrphy_csb0				A	NA	NA	NA	
DDR_CS1N	DDR_CS1N	B9	ddrphy_csb1				A	NA	NA	NA	
DDR_RETEN_IN	DDR_RETEN_IN	E10	ddrphy_bufferen				A	NA	NA	NA	
DDR_ODT0	DDR_ODT0	D17	ddrphy_odt0				A	NA	NA	NA	
DDR_ODT1	DDR_ODT1	C17	ddrphy_odt1				A	NA	NA	NA	
DDR_RASN	DDR_RASN	A10	ddrphy_rasb				A	NA	NA	NA	
DDR_RESETN	DDR_RESETN	E11	ddrphy_resetn				A	NA	NA	NA	
DDR_WEN	DDR_WEN	C10	ddrphy_web				A	NA	NA	NA	

Notes :

①: Pad types : I = input , O = output , I/O = input/output (bidirectional) ,
 AP = Analog Power , AG = Analog Ground
 DP = Digital Power , DG = Digital Ground
 A = Analog

②: Output Drive strength is configurable, it's the suggested value in this table. Unit is mA , only Digital IO have drive value

③:Reset state: I = input without any pull resistor O = output

④:It is die location. For examples, "Left side" means that all the related IOs are always in left side of die

⑤:Power supply means that all the related IOs are in this IO power domain. If multiple powers are included, they are connected together in one IO power ring

⑥:The pull up/pull down is configurable.

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2.8 Pin Name Descriptions

This sub-chapter will focus on the detailed function description of every pins based on different interface.

Table 2-3 RK3368 Pin Name Description list

Interface	Pin Name	Direction	Description
Misc	XIN24M	I	Clock input of 24MHz crystal
	XOUT24M	O	Clock output of 24MHz crystal
	CLK32K	I	Clock input of 32.768KHz
	NPOR	I	Chip hardware reset
	ddr_reten	O	DDR IO retention control
	tsadc_int	O	TSADC trigger to shut down chip
	global_pwroff	O	System power off control port
	pmic_sleep	O	Sleep control to external PMIC chip
JTAG	jtag_trstn	I	Cortex-A53 JTAG interface reset input
	jtag_tck	I	Cortex-A53 JTAG interface clock input/SWD interface clock input
	jtag_tdi	I	Cortex-A53 JTAG interface TDI input
	jtag_tms	I/O	Cortex-A53 JTAG interface TMS input/SWD interface data out
	jtag_tdo	O	Cortex-A53 JTAG interface TDO output
MCUJTAG	mcujtag_trstn	I	mcu JTAG interface reset input
	mcujtag_tck	I	mcu JTAG interface clock input/SWD interface clock input
	mcujtag_tdi	I	mcu JTAG interface TDI input
	mcujtag_tms	I/O	mcu JTAG interface TMS input/SWD interface data out
	mcujtag_tdo	O	mcu JTAG interface TDO output
GPUJTAG	gpujtag_trstn	I	gpu JTAG interface reset input
	gpujtag_tck	I	gpu JTAG interface clock input/SWD interface clock input
	gpujtag_tdi	I	gpu JTAG interface TDI input
	gpujtag_tms	I/O	gpu JTAG interface TMS input/SWD interface data out
	gpujtag_tdo	O	gpu JTAG interface TDO output
ETM Trace	trace_clk	O	Cortex-A53 ETM trace port clk
	trace_ctl	O	Cortex-A53 ETM trace port control
	trace_data <i>(i=0~15)</i>	O	Cortex-A53 ETM trace port data
SD/MMC Host Controller	sdmmc_clkout	O	sdmmc card clock.
	sdmmc_cmd	I/O	sdmmc card command output and reponse input.
	sdmmc_data <i>i</i> <i>(i=0~3)</i>	I/O	sdmmc card data input and output.
	sdmmc_detect_n	I	sdmmc card detect signal, a 0 represents presence of card.
SDIO Host Controller	sdiox_clkout(<i>x=0,1</i>)	O	sdio card clock.

Interface	Pin Name	Direction	Description
	sdiox_cmd($x=0,1$)	I/O	sdio card command output and reponse input.
	sdiox_datai ($i=0\sim3$) ($x=0,1$)	I/O	sdio card data input and output.
	sdiox_detectn($x=0,1$)	I	sdio card detect signal, a 0 represents presence of card.
	sdiox_wrprt($x=0,1$)	I	sdio card write protect signal, a 1 represents write is protected.
	sdiox_pwren($x=0,1$)	O	sdio card power-enable control signal
	sdiox_intn($x=0,1$)	O	sdio card interrupt indication
	sdiox_bkpwr($x=0,1$)	O	the back-end power supply for embedded device
eMMC Interface	emmc_clkout	O	emmc card clock.
	emmc_cmd	I/O	emmc card command output and reponse input.
	emmc_datai ($i=0\sim7$)	I/O	emmc card data input and output.
	emmc_pwren	O	emmc card power-enable control signal
	emmc_rstnout	O	emmc card reset signal
DMC	DDR _x _CK($x=0,1$)	O	Active-high clock signal to the memory device.
	DDR _x _CK_N($x=0,1$)	O	Active-low clock signal to the memory device.
	DDR _x _CKE _i ($i=0,1$) ($x=0,1$)	O	Active-high clock enable signal to the memory device for two chip select.
	DDR _x _CSN _i ($i=0,1$) ($x=0,1$)	O	Active-low chip select signal to the memory device. A There are two chip select.
	DDR _x _RASN($x=0,1$)	O	Active-low row address strobe to the memory device.
	DDR _x _CASN($x=0,1$)	O	Active-low column address strobe to the memory device.
	DDR _x _WEN($x=0,1$)	O	Active-low write enable strobe to the memory device.
	DDR _x _BA[2:0] ($x=0,1$)	O	Bank address signal to the memory device.
	DDR _x _ADDR[15:0] ($x=0,1$)	O	Address signal to the memory device.
	DDR _x _DQ[31:0] ($x=0,1$)	I/O	Bidirectional data line to the memory device.
	DDR _x _DQS[3:0] ($x=0,1$)	I/O	Active-high bidirectional data strobes to the memory device.
	DDR _x _DQS_B[3:0] ($x=0,1$)	I/O	Active-low bidirectional data strobes to the memory device.
DDR _x _DM[3:0] ($x=0,1$)	O	Active-low data mask signal to the memory device.	

Interface	Pin Name	Direction	Description
	DDR _x _ODT _i (i=0,1) (x=0,1)	O	On-Die Termination output signal for two chip select.
	DDR _x _RETEN(x=0,1)	I	Active-low retention latch enable input
	DDR _x _RESET(x=0,1)	O	DDR3 reset signal to the memory device
	DDR _x _VREF _i (i=0,1,2,3) (x=0,1)	I/O	Reference Voltage input for three regions of DDR IO
	DDR _x _PZQ(x=0,1)	I/O	ZQ calibration pad which connects 240ohm±1% resistor
NandC	flash_wp	O	Flash write-protected signal
	flash_ale	O	Flash address latch enable signal
	flash_cle	O	Flash command latch enable signal
	flash_wrn	O	Flash write enable and clock signal
	flash_rdn	O	Flash read enable and write/read signal
	flash_data _i (i=0~7)	I/O	Flash data inputs/outputs signal
	flashx_dqs	I/O	Flash data strobe signal
	flashx_rdy	I	Flash ready/busy signal
	flashx_csn _i (i=0~4)	O	Flash chip enable signal for chip i, i=0~7
HSADC	hsadc_data _i (i=0~1)	I	gps data(i=0,1)
	gps_clk	I	hsadc/tsi/gps reference clock
TSP Interface	ts_clk	I/O	TSI reference clock
	ts_data _i (i=0~7)	I	TSI data(i=0~7)
	ts_sync	I	TSI synchronizer signal
	ts_valid	I	TSI valid signal
	ts_err	I	TSI fail signal
I2S_8ch/PCM Controller	i2s_clk	O	I2S/PCM clock source
	i2s_sclk	I/O	I2S/PCM serial clock
	i2s_lrckrx	I/O	I2S/PCM left & right channel signal for receiving serial data, synchronous left & right channel in I2S mode and the beginning of a group of left & right channels in PCM mode
	i2s_sdi	I	I2S/PCM serial data input
	i2s_sdo _i (i=0~3)	O	I2S/PCM serial data output
	i2s_lrcktx	I/O	I2S/PCM left & right channel signal for transmitting serial data, synchronous left & right channel in I2S mode and the beginning of a group of left & right channels in PCM mode
I2S_2CH/PCM	pcm_clk	I/O	I2S/PCM serial clock
Controller	pcm_sync	I/O	I2S/PCM left & right channel signal for receiving serial data, synchronous left & right channel in I2S mode and the beginning of a group of left & right channels in PCM mode

Interface	Pin Name	Direction	Description
	i2s_sdi	I	I2S/PCM serial data input
	i2s_sdo	O	I2S/PCM serial data output
SPDIF transmitter	spdif_tx	O	spdif biphase data output
SPI Controller	spix_clk(x=0,2)	I/O	spi serial clock
	spix_csny (x=0,2)(y=0,1)	I/O	spi chip select signal, low active
	spix_txd(x=0,2)	O	spi serial data output
	spix_rxd(x=0,2)	I	spi serial data input
SFC Controller	sfc_clk	I/O	sfc serial clock
	sfc_csnx(x=0,1)	I/O	sfc chip select signal, low active
	sfc_siox(x=0,3)	O	sfc serial data output
LCDC	lcdc_dclk	O	LCDC RGB interface display clock out, MCU i80 interface RS signal
	lcdc_vsync	O	LCDC RGB interface vertical sync pulse, MCU i80 interface CSN signal
	lcdc_hsync	O	LCDC RGB interface horizontal sync pulse, MCU i80 interface WEN signal
	lcdc_den	O	LCDC RGB interface data enable, MCU i80 interface REN signal
	lcdc_data(i=0~23)	O	LCDC data output/input
	vop_pwm	O	VOP_BIG CABAC PWM control signal
Camera IF	cif_clkln	I	Camera0 interface input pixel clock
	cif_clkout	O	Camera0 interface output work clock
	cif_vsync	I	Camera0 interface vertical sync signal
	cif_href	I	Camera0 interface horizontal sync signal
	cif_data i(i=0~11)	I	Camera0 interface input pixel data
PWM	pwm3	I/O	Pulse Width Modulation output
	pwm2	I/O	Pulse Width Modulation output
	pwm1	I/O	Pulse Width Modulation output
	pwm0	I/O	Pulse Width Modulation output
I2C	i2c0pmu_sda	I/O	I2C_PMU data
	i2c0pmu_scl	I/O	I2C_PMU clock
	i2c1sensor_sda	I/O	I2C1_SENSOR data
	i2c1sensor_scl	I/O	I2C1_SENSOR clock
	i2c2audio_sda	I/O	I2C2_AUDIO data
	i2c2audio_scl	I/O	I2C2_AUDIO clock
	i2c3cam_sda	I/O	I2C3_CAM data
	i2c3cam_scl	I/O	I2C3_CAM clock
	i2c4tp_sda	I/O	I2C4_TP data
	i2c4tp_scl	I/O	I2C4_TP clock

Interface	Pin Name	Direction	Description
	i2c5hdmi_sda	I/O	I2C5_HDMI data
	i2c5hdmi_scl	I/O	I2C5_HDMI clock
UART	uart0bt_sin	I	UART_BT searial data input
	uart0bt_sout	O	UART_BT searial data output
	uart0bt_ctsn	I	UART_BT clear to send
	uart0bt_rtsn	O	UART_BT request to send
	uart1bb_sin	I	UART_BB searial data input
	uart1bb_sout	O	UART_BB searial data output
	uart1bb_ctsn	O	UART_BB clear to send
	uart1bb_rtsn	I	UART_BB request to send
	uart2dbg_sin	I	UART_DBG searial data input
	uart2dbg_sout	O	UART_DBG searial data output
	uart3gps_sin	I	UART_GPS searial data input
	uart3gps_sout	O	UART_GPS searial data output
	uart3gps_ctsn	I	UART_GPS clear to send
	uart3gps_rtsn	O	UART_GPS request to send
	uart4exp_sin	I	UART_EXP searial data input
	uart4exp_sout	O	UART_EXP searial data output
	uart4exp_ctsn	I	UART_EXP clear to send
	uart4exp_rtsn	O	UART_EXP request to send
	GMAC	mac_clk	I/O
mac_txclk		O	RGMIIX TX clock output
mac_rxclk		I	RGMIIX RX clock input
mac_mdc		O	GMAC management interface clock
mac_mdio		I/O	GMAC management interface data
mac_txdi($i=0\sim3$)		O	GMAC TX data
max_rxdj($j=0\sim3$)		I	GMAC RX data
mac_txen		O	GMAC TX data enable
mac_rxdv		I	GMAC RX data valid signal
mac_rxer		I	GMAC RX error signal
mac_col		I	PHY Collision signal
mac_crs		I	PHY CRS signal
USB 2.0 PHY	USB0_ID	I/O	USB 2.0 ID input
	USB0_DM	I/O	USB 2.0 channel0 data DM
	USB0_DP	I/O	USB 2.0 channel0 data DP
	USB1_DM	I/O	USB 2.0 channel0 data DM

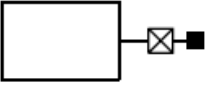
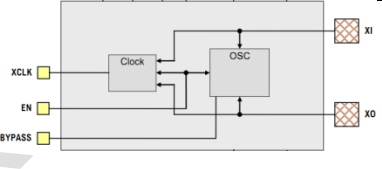
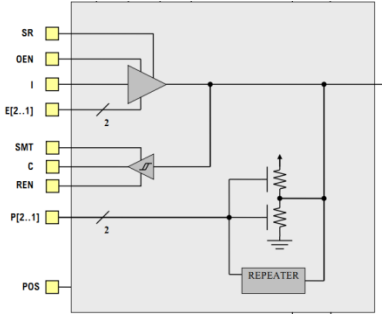
Interface	Pin Name	Direction	Description
	USB1_DP	I/O	USB 2.0 channel0 data DP
USB Host 2.0 (2 channel)	USB_RBIAS	I	Connect 135ohm resister to ground
	USB_VBUS	I	USB 2.0 VBUS input
USIC	USIC_DATA	N/A	USIC DATA signal
	USIC_STROBE	N/A	USIC STROBE signal
SAR-ADC	SARADC_AIN[i] (i=0~2)	N/A	SAR-ADC input signal for 3 channel
eFuse	EFUSE_VDDQ	N/A	eFuse program and sense power
SIM Card	sc_clk	O	Smart card clock output
	sc_rst	O	Smart card reset output
	sc_io	I/O	Smart card data
	sc_detect	O	Smart card detect input
	sc_vcc18v	O	Smart card 1.8V voltage select
	sv_vcc33v	O	Smart card 3.3V voltage select
ISP	isp_shutteren	O	Hold signal for shutter open
	isp_flashtrigout	O	Hold signal for flash light
	isp_prelighttrig	O	Hold signal for prelight
	isp_shuttertrig	I	External shutter trigger pulse
	isp_flashtrigin	I	External flash trigger pulse
eDP	EDP_TXiP(i=0~3)	O	eDP data lane positive output
	EDP_TXiN(i=0~3)	O	eDP data lane negative output
	EDP_DC_TP	O	eDP PHY DC test point
	EDP_AUXP	I/O	eDP CH-AUX positive differential output
	EDP_AUXN	I/O	eDP CH-AUX negative differential output
	EDP_R_BIAS	I	Let it floating
	EDP_OSC_CLK_24M	I	24MHz input reference clock
	edp_hotplug	I	eDP external hot plug signal
	edphdmi_cecinout	I/O	eDP HDMI CEC bus
	edphdmi2c_sda	I/O	eDP HDMI I2C data
	edphdmi2c_scl	I/O	eDP HDMI I2C clock
HDMI	HDMI_TMDSDATANI(i=0~2)	O	HDMI negative TMDS differential line driver data output
	HDMI_TMDSDATAPI(i=0~2)	O	HDMI positive TMDS differential line driver data output
	HDMI_TMDSCLKN	O	HDMI negative TMDS differential line driver clock output

Interface	Pin Name	Direction	Description
	HDMI_TMDCLKP	O	HDMI positive TMDS differential line driver clock output
	HDMI_RESREF	I/O	HDMI reference resistor connection
	HDMI_HPD	I/O	HDMI hot plug detect signal
	HDMI_DDCCEC	I/O	HDMI ground reference for the hot plug detect signal
MIPI_DSI	MIPI_DSI_DNi($i=0\sim3$)	I/O	MIPI DSI negative differential data line transceiver output
	MIPI_DSI_DPi($i=0\sim3$)	I/O	MIPI DSI positive differential data line transceiver output
	MIPI_DSI_CLKP	I/O	MIPI DSI positive differential clock line transceiver output
	MIPI_DSI_CLKN	I/O	MIPI DSI negative differential clock line transceiver output
	MIPI_DSI_RBIAS	I/O	MIPI DSI external resistor connection
MIPI_CSI	MIPI_CSI_DNi($i=0\sim3$)	I/O	MIPI CSI negative differential data line transceiver output
	MIPI_CSI_DPi($i=0\sim3$)	I/O	MIPI CSI positive differential data line transceiver output
	MIPI_CSI_CLKP	I/O	MIPI CSI positive differential clock line transceiver output
	MIPI_CSI_CLKN	I/O	MIPI CSI negative differential clock line transceiver output
	MIPI_CSI_RBIAS	I/O	MIPI CSI external resistor connection

2.9 IO Type

The following list shows IO type except DDR IO and all of Power/Ground IO.

Table 2-4 RK3368 IO Type List

Type	Diagram	Description	Pin Name
A		Analog IO Cell with IO voltage	EFUSE_VQPS
B		Crystal Oscillator with high enable	XIN24M/XOUT24M
C		Tri-state output pad with input, which pullup/pulldown, slew rate and drive strength is configurable	Part of digital GPIO

Chapter 3 Electrical Specification

3.1 Absolute Maximum Ratings

Table 3-1 RK3368 absolute maximum ratings

Parameters	Related Power Group	Max	Unit
DC supply voltage for Internal digital logic	CPU_VDD, LOGIC_VDD, PMU_VDD_1V0, USB_AVDD_1V0 DDRPLL_VDD_1V0	1.5	V
DC supply voltage for Digital GPIO (except for SAR-ADC, PLL, USB, DDR, MIPI PHY, LVDS, eDP, HDMI IO)	PMUIO_VDD APIO1_VDD APIO2_VDD APIO3_VDD APIO4_VDD LCDC_VDD SDMMC_VDD FLASH_VDD DVPIO_VDD	3.8	V
DC supply voltage for DDR IO	DDR_VDD	1.8	V
DC supply voltage for Analog part of PLL	APLL_AVDD_1V0 C/DPLL_AVDD_1V0 G/NPLL_AVDD_1V0	1.2	V
DC supply voltage for Analog part of USB OTG/Host2.0	USB_AVDD_1V8 USB_AVDD_3V3	2.1 3.8	V
DC supply voltage for Analog part of USIC	USIC_AVDD_1V2	1.4	V
Analog Input voltage for SAR-ADC/TS- ADC	ADC_AVDD_1V8	2.1	V
DC supply voltage for Analog part of MIPI_DSI/LVDS/TTL combo PHY	LVDS/MIPI_AVDD_1V0 LVDS/MIPI_AVDD_1V8 LVDS/MIPI_AVDD_3V3	1.2 2.1 3.8	V
DC supply voltage for Analog part of MIPI_CSI PHY	MIPI_CSI_AVDD_1V0	1.2	V
DC supply voltage for Analog part of eDP	EDP_AVDD_1V0 EDP_AVDD_1V8	1.2 2.1	V
DC supply voltage for Analog part of HDMI	HDMI_AVDD_1V0 HDMI_AVDD_1V8	1.2 2.1	V
Analog Input voltage for DP/DM/VBUS of USB OTG/Host2.0		5	V
Digital input voltage for input buffer of GPIO		3.8	V
Digital output voltage for output buffer of GPIO		3.6	V
Storage Temperature	Tstg	125	°C
Max Conjunction Temperature	Tj	125	°C

Absolute maximum ratings specify the values beyond which the device may be damaged permanently. Long-term exposure to absolute maximum ratings conditions may affect device reliability.

3.2 Recommended Operating Conditions

Table 1-6 describes the recommended operating condition for every clock domain.

Table 3-2 RK3368 recommended operating conditions

Parameters	Symbol	Min	Typ	Max	Units
Internal digital logic Power	CPU_VDD, LOGIC_VDD, PMU_VDD_1V0, USB_AVDD_1V0 DDRPLL_VDD_1V0	0.9	1.0	1.4	V
Digital GPIO Power(3.3V/2.5V/1.8V)	PMUIO_VDD APIO1_VDD APIO2_VDD APIO3_VDD APIO4_VDD LCDC_VDD SDMMC_VDD FLASH_VDD DVPIO_VDD FLASH_VDD	3 2.25 1.62	3.3 2.5 1.8	3.6 2.75 1.98	V
DDR IO (DDR3 mode) Power	DDR_VDD	1.425	1.5	1.575	V
DDR IO (DDR3L mode) Power	DDR_VDD	1.283	1.35	1.417	V
DDR IO (LPDDR2/LPDDR3 mode) Power	DDR_VDD	1.14	1.2	1.3	V
PLL Analog Power	APLL_AVDD_1V0 C/DPLL_AVDD_1V0 G/NPLL_AVDD_1V0	0.9	1.0	1.1	V
SAR-ADC/TSADC Analog Power	ADC_AVDD_1V8	1.62	1.8	1.98	V
USB OTG/Host2.0 Digital Power	USB_AVDD_1V0	0.9	1.0	1.1	V
USB OTG/Host2.0 Analog Power(1.8V)	USB_AVDD_1V8	1.62	1.8	1.98	V
USB OTG/Host2.0 Analog Power(3.3V)	USB_AVDD_3V3	3.069	3.3	3.63	V
USIC Analog Power	USIC_AVDD_1V2	1.08	1.2	1.32	V
DSI combo PHY Analog Power(1.0V)	LVDS/MIPI_AVDD_1V0	0.9	1.0	1.1	V
DSI combo PHY Analog Power(1.8V)	LVDS/MIPI_AVDD_1V8	1.62	1.8	1.98	V
DSI combo PHY Analog Power(3.3V)	LVDS/MIPI_AVDD_3V3	3.0	3.3	3.6	V
eDP Analog Power(1.0V)	EDP_AVDD_1V0	0.9	1.0	1.1	V
eDP Analog Power(1.8V)	EDP_AVDD_1V8	1.62	1.8	1.98	V
HDMI Analog Power(1.0V)	HDMI_AVDD_1V0	0.9	1.0	1.1	V
HDMI Analog Power(1.8V)	HDMI_AVDD_1V8	1.62	1.8	1.98	V
PLL input clock frequency		N/A	24	N/A	MHz
Ambient Operating Temperature \varnothing	Ta	0	25	80	°C
Max CPU frequency of A53 for little cluster				1.2	GHz
Max CPU frequency of A53 for big cluster				1.5	GHz
Max GPU frequency				600	MHz

Notes : ^① Symbol name is same as the pin name in the io descriptions

^② with the reference software setup, the reference software will limit the chipset temperature about 80 °C

3.3 DC Characteristics

Table 3-3 RK3368 DC Characteristics

	Parameters	Symbol	Min	Typ	Max	Units
Digital GPIO @3.3V	Input Low Voltage	Vil	-0.3	0	3.3x0.3	V
	Input High Voltage	Vih	3.3x0.7	3.3	3.3+0.3	V
	Output Low Voltage	Vol	-0.3	NA	NA	V
	Output High Voltage	Voh	NA	NA	3.6	V
	Threshold Point	Vtr+	1.53	1.46	1.43	V
		Vtr-	1.19	1.12	1.05	V
	Pullup Resistor	Rpu	33.7	58	101.5	Kohm
Pulldown Resistor	Rpd	34.2	60.1	109.3	Kohm	
Digital GPIO @1.8V	Input Low Voltage	Vil	-0.3	0	1.8x0.3	V
	Input High Voltage	Vih	1.8x0.7	1.8	1.8 + 0.3	V
	Output Low Voltage	Vol	-0.3	NA	NA	V
	Output High Voltage	Voh	NA	NA	1.8+0.3	V
	Threshold Point	Vtr+	1.23	1.12	1.03	V
		Vtr-	0.91	0.82	0.73	V
	Pullup Resistor	Rpu	35	62.9	120	Kohm
Pulldown Resistor	Rpd	35.1	61	113.9	Kohm	
DDR IO @DDR3 mode	Input High Voltage	Vih_dds	VREF + 0.10	NA	DDR_VDD+0.4	V
	Input Low Voltage	Vil_dds	-0.4	NA	VREF - 0.10	V
	Output High Voltage	Voh_dds	0.9xDDR_VDD	NA	N/A	V
	Output Low Voltage	Vol_dds	N/A	NA	0.1*DDR_VDD	V
	Input termination resistance(ODT) to VDDIO_DDRi/2 (i=0~6)	Rtt	100 54 36	120 60 40	140 66 44	Ohm
DDR IO @LPDDR2/ LPDDR3 mode	Input High Voltage	Vih_dds	VREF + 0.13	NA	DDR_VDD	V
	Input Low Voltage	Vil_dds	0	NA	VREF - 0.13	V
	Output High Voltage	Voh_dds	NA	NA	0.9*DDR_VDD	V
	Output Low Voltage	Vol_dds	0.1*DDR_VDD	NA	NA	V
MIPI_DSI IO @LVDS mode	Output High Voltage	Voh	NA	NA	1100	mV
	Output Low Voltage	Vol	700	NA	NA	mV
	Output differential voltage	Vod	250	NA	400	mV
	Output offset voltage	Vos	825	NA	975	mV
	Output impedance, single ended	Ro	40	NA	140	Ω
	Ro mismatch between A & B	ΔRo	NA	NA	10	%
	Change in Vod between 0 and 1	ΔVod	NA	NA	25	mV
	Change in Vod between 0 and 1	ΔVos	NA	NA	25	mV
MIPI_DSI IO @TTL mode	Output High Voltage	Voh	3	3.3	NA	V
	Output Low Voltage	Vol	NA	0	0.2	V
	Short-Circuit Output Current	Ios	NA	35	60	mA
	Output impedance	Zolp	40	NA	460	Ω
MIPI_DSI IO @MIPI mode	HS TX static Common-mode voltage	VCMTX	150	200	250	mV
	VCMTX mismatch when output is Differential-1 or Differential-0	ΔVCMTX(1,0)	NA	NA	5	mV
	HS transmit differential voltage	VOD	140	200	270	mV
	VOD mismatch when output is Differential-1 or Differential-0	ΔVOD	NA	NA	10	mV
	HS output high voltage	VOHHS	NA	NA	360	mV

Parameters		Symbol	Min	Typ	Max	Units
	Single ended output impedance	ZOS	40	50	62.5	Ω
	Single ended output impedance mismatch	Δ ZOS	NA	NA	10	%
HDMI	Single-ended standby voltage	Voff	avddtmds \pm 10			mV
	Single-ended output swing voltage RT=50 Ω	Vswing	400	NA	600	mV
		Vswing_data	400	NA	600	mV
		Vswing_clock	200	NA	600	mV
	Single-ended output high voltage	Vh	avddtmds \pm 10			mV
			avddtmds-200	NA	avddtmds+10	mV
		Vh_data	avddtmds-400	NA	avddtmds+10	mV
		Vh_clock	avddtmds-400	NA	avddtmds+10	mV
	Single-ended output low voltage	Vl	avddtmds-600	NA	avddtmds-400	mV
			avddtmds-700	NA	avddtmds-400	mV
		Vl_data	avddtmds-1000	NA	avddtmds-400	mV
		Vl_clock	avddtmds-1000	NA	avddtmds-200	mV
Differential source termination load	Rterm	50	NA	200	Ω	

3.4 Electrical Characteristics for General IO

Table 3-4 RK3368 Electrical Characteristics for Digital General IO

Parameters		Symbol	Test condition	Min	Typ	Max	Units
Digital GPIO @3.3V	Input leakage current	Ii	Vin = 3.3V or 0V	NA	NA	10	μ A
	Tri-state output leakage current	Ioz	Vout = 3.3V or 0V	NA	NA	10	μ A
	High level input current	Iih	Vin = 3.3V, pulldown disabled	NA	NA	10	μ A
			Vin = 3.3V, pulldown enabled	NA	NA	106.4	μ A
	Low level input current	Iil	Vin = 0V, pullup disabled	NA	NA	10	μ A
			Vin = 0V, pullup enabled	NA	NA	107.8	μ A
Digital GPIO @1.8V	Input leakage current	Ii	Vin = 1.8V or 0V	NA	NA	10	μ A
	Tri-state output leakage current	Ioz	Vout = 1.8V or 0V	NA	NA	10	μ A
	High level input current	Iih	Vin = 1.8V, pulldown disabled	NA	NA	10	μ A
			Vin = 1.8V, pulldown enabled	NA	NA	61.3	μ A
	Low level input current	Iil	Vin = 0V, pullup disabled	NA	NA	10	μ A
			Vin = 0V, pullup enabled	NA	NA	61.4	μ A

3.5 Electrical Characteristics for PLL

Table 3-5 RK3368 Electrical Characteristics for PLL

Parameters		Symbol	Test condition	Min	Typ	Max	Units
PLL	Divided reference frequency range	Fin		0.269	NA	2200	MHz
	output frequency range	Fout		0.440	N/A	2200	MHz

Parameters	Symbol	Test condition	Min	Typ	Max	Units
Lock time	Tlt		N/A	NA	500	Cycles of divided reference clock
Power consumption (normal mode)	N/A		N/A	3	N/A	mW
Period jitter (P-P)	N/A		N/A	NA	+/-2.5	%
Junction temperature	N/A			70	125	°C

3.6 Electrical Characteristics for SAR-ADC

Table 3-6 RK3368 Electrical Characteristics for SAR-ADC

Parameters	Symbol	Test condition	Min	Typ	Max	Units
ADC resolution			N/A	10	N/A	bits
Conversion speed	Fs	The duty cycle should be between 40%~60%	NA	N/A	1	MSPS
Differential Non Linearity	DNL		N/A	±1	N/A	LSB
Integral Non Linearity	INL		N/A	±2	N/A	LSB
Gain Error	Egain		-8	N/A	8	LSB
Offset Error	Eoffset		-8	N/A	8	mV
Analog Supply Current(VDDA_SARADC)			N/A	200	N/A	uA
Digital Supply Current			N/A	50	N/A	uA
Power Down Current from AVDD			NA	0.5	NA	uA
Power Down Current from DVDD			N/A	1	N/A	uA
Power up time			N/A	7	N/A	1/Fs

3.7 Electrical Characteristics for TSADC

Table 3-7 RK3368 Electrical Characteristics for TSADC

Parameters	Symbol	Test condition	Min	Typ	Max	Units
ADC resolution			N/A	8	N/A	bits
TSADC Accuracy	Fs		NA	N/A	+/-5	°C
Active power			N/A	0.1	N/A	mW
Clock Frequency	Fclk		NA	NA	550	KHz
Power Down Current from DVDD			N/A	1	N/A	uA

3.8 Electrical Characteristics for USB Interface

Table 3-8 RK3368 Electrical Characteristics for USB Interface

Parameters	Symbol	Test condition	Min	Typ	Max	Units
Transmitter						
High input level	VIH		NA	1.0	NA	V
Low input level	VIL		NA	0	NA	V
Output resistance	ROUT	Classic mode (Vout = 0 or 3.3V)	40.5	45	49.5	ohms
		HS mode (Vout = 0 to 800mV)	40.5	45	49.5	ohms
Output Capacitance	COUT	seen from D+ or D-			3	pF

Parameters	Symbol	Test condition	Min	Typ	Max	Units
Output Common Mode Voltage	VM	Classic (LS/FS) mode	1.45	1.65	1.85	V
		HS mode	0.175	0.2	0.225	V
Differential output signal high	VOH	Classic (LS/FS); Io=0mA	2.97	3.3	3.63	V
		Classic (LS/FS); Io=6mA	2.2	0.3	NA	V
		HS mode; Io=0mA	360	400	440	mV
Differential output signal low	VOL	Classic (LS/FS); Io=0mA	-0.33	0	0.33	V
		Classic (LS/FS); Io=6mA	NA	0.3	0.8	V
		HS mode; Io=0mA	-40	0	40	mV
Receiver						
Receiver sensitivity	RSENS	Classic mode		+ -250		mV
		HS mode		+ -25		mV
Receiver common mode	RCM	Classic mode	0.8	1.65	2.5	V
		HS mode (differential and squelch comparator)	0.1	0.2	0.3	V
		HS mode (disconnect comparator)	0.5	0.6	0.7	V
Input capacitance (seen at D+ or D-)			NA	NA	3	pF
Squelch threshold			100	112	150	mV
Disconnect threshold			570	590	625	mV
High output level	VOH		NA	3.3	NA	V
Low output level	VOL		NA	0	NA	V

3.9 Electrical Characteristics for DDR IO

Table 3-9 RK3368 Electrical Characteristics for DDR IO

Parameters		Symbol	Test condition	Min	Typ	Max	Units
DDR IO @DDR3 mode	Input leakage current, SSTL mode, unterminated		@ 1.5V , 125°C	NA	0		uA
DDR IO @DDR3L mode	Input leakage current		@ 1.35V , 125°C	NA	0	NA	nA
DDR IO @LPDDR2/LPDDR3 mode	Input leakage current		@ 1.2V , 125°C	NA	0	0.49	nA

3.10 Electrical Characteristics for eFuse

Table 3-10 RK3368 Electrical Characteristics for eFuse

	Parameters	Symbol	Test condition	Min	Typ	Max	Units
Active mode	VDD current in Read mode	Iread_vdd	nomal read	15	20	30	mA
	VDD current in PGM mode	Ipgm_vdd	STROBE high	0.5	1	2.5	mA
	VQPS current in PGM mode	Ipgm_vqps	STROBE high	5	10	15	mA
standby mode	VDD current in standby mode	Istandby_vdd	Standby	0.2	0.5	2	A

3.11 Electrical Characteristics for HDMI

Table 3-11 RK3368 Electrical Characteristics for HDMI

Parameters	Symbol	Test condition	Min	Typ	Max	Units
Differential output signal rise time	tR	20~80% RL=50Ω	75	NA	0.4UI	ps
	tR_DATA	20~80% RL=50Ω	42.5	NA	NA	ps
	tR_CLOCK	20~80% RL=50Ω	75	NA	NA	ps
Differential output signal fall time	tF	20~80% RL=50Ω	75	NA	NA	ps
	tF_DATA	20~80% RL=50Ω	42.5	NA	NA	ps
	tF_CLOCK	20~80% RL=50Ω	75	NA	NA	ps

3.12 Electrical Characteristics for MIPI PHY

Table 3-12 RK3368 Electrical Characteristics for MIPI PHY

Parameters	Symbol	Test condition	Min	Typ	Max	Units
HS Transmitter AC specifications (MIPI mode)						
Common-mode variations above 450 MHz	ΔVCMTX(HF)		NA	NA	15	mVRMS
Common-mode variations between 50MHz - 450MHz	ΔVCMTX(LF)		NA	NA	25	mVPEAK
20%-80% rise time and fall time	TR and TF		150	NA	NA	ps
HS Receiver AC specifications (MIPI mode)						
Common-mode interference beyond 450 MHz	ΔVCMRX(HF)		NA	NA	100	mV
Common-mode interference	ΔVCMRX(LF)		-50	NA	50	mV
Common-mode termination	CCM		NA	NA	60	pF
HS transmitter AC specification(LVDS)						
Vod fall time 20-80%	Tfall	Rload=100 ohms+1%	100		250	ps
Vod rise time 20-80	Rrise	Rload=100 ohms+1%	100		250	ps
Differential skew	Tskew	Tskew			30	ps
LP receiver AC specifications(only for MIPI mode)						
Input pulse rejection	eSPIKE		NA	NA	300	V.ps
Minimum pulse width response	TMIN-RX		20	NA	NA	ns
Peak interference amplitude	VINT		NA	NA	200	mV
Interference frequency	fINT		450	NA	NA	MHz
LP Transmitter AC Specifications(only for MIPI mode)						
15%-85% rise time and fall time	TRLP/TFLP		NA	NA	25	ns
30%-85% rise time and fall time	TREOT		NA	NA	35	ns
Pulse width of exclusiveOR clock the LP	TLP-PULSE-TX	First LP exclusive-OR clock pulse after Stop state or last pulse before Stop state	40	NA	NA	ns
		All other pulse	20	NA	NA	
Period of the LP exclusive OR clock	TLP-PER-TX		90	NA	NA	ns
Slew rate @ CLOAD=0pF	δV/δtSR		NA	NA	500	mV/ns

Parameters	Symbol	Test condition	Min	Typ	Max	Units
HS Transmitter AC specifications (MIPI mode)						
Slew rate @ CLOAD=5pF			NA	NA	300	mV/ns
Slew rate @ CLOAD=20pF			NA	NA	250	mV/ns
Slew rate @ CLOAD=70pF			NA	NA	150	mV/ns
Slew rate @ CLOAD=0 to 70pF(Falling Edge Only)			30	NA	NA	mV/ns
Slew rate @ CLOAD=0 to 70pF(Rising Edge Only)			30	NA	NA	mV/ns
Slew rate @ CLOAD=0 to 70pF(Rising Edge Only)			30-0.075 * (VO,INST - 700)	NA	NA	mV/ns
Load capacitance	CLOAD		0	NA	70	pF
CMOS Transmitter DC Specifications(CMOS mode)						
Maximum data rate	DMAX		NA	200	NA	Mbit/s
15%-85% rise time and fall time	TRLP/TFLP		1	1.5	2	Ns
Slew rate, transition region	SR		20	27	30	V/ns

Chapter 4 Thermal Management

4.1 Overview

For reliability and operability concerns, the absolute maximum junction temperature of RK3368 has to be below 125℃.

4.2 Package Thermal Characteristics

Table 4-1 provides the thermal resistance characteristics for the package used on RK3368. The resulting simulation data for reference only, please prevail in kind test.

Table 4-1 RK3368 Thermal Resistance Characteristics

Package (TFBGA)	Power(W)	θ_{JA} (℃/W)	θ_{JB} (℃/W)	θ_{JC} (℃/W)
RK3368	4.5	14.595	6.70	3.683

Note: The testing PCB is based on 6 layers, 107x105 mm, 1 mm Thickness, ambient temperature is 25℃,